

DSC-T70/T75

SERVICE MANUAL

LEVEL 2

Ver. 1.0 2007.08

Revision History

Internal memory
ON BOARD



Photo: Silver

US Model
Canadian Model
AEP Model
UK Model
E Model
Australian Model
Hong Kong Model
Chinese Model
Korea Model
Argentine Model
Brazilian Model
Japanese Model
Tourist Model

Link

SPECIFICATIONS	DISASSEMBLY	SCHEMATIC DIAGRAMS
MODEL INFORMATION TABLE	BLOCK DIAGRAMS	PRINTED WIRING BOARDS
SERVICE NOTE	FRAME SCHEMATIC DIAGRAM	REPAIR PARTS LIST

• Precaution on Replacing the SY-183 Board

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque \triangle sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

DIGITAL STILL CAMERA

SONY®



SPECIFICATIONS

Camera

[System]

Image device: 7.18 mm (1/2.5 type) color CCD,
Primary color filter
Total pixel number of camera:
Approx. 8 286 000 pixels
Effective pixel number of camera:
Approx. 8 083 000 pixels
Lens: Carl Zeiss Vario-Tessar 3× zoom lens $f =$
6.33 – 19.0 mm (38 – 114 mm when
converted to a 35 mm still camera) F3.5 – 4.3
Exposure control: Automatic exposure, Scene
Selection (10 modes)
White balance: Automatic, Daylight, Cloudy,
Fluorescent 1, 2, 3, Incandescent, Flash
File format (DCF compliant):
Still images: Exif Ver. 2.21 JPEG compliant,
DPOF compatible
Movies: MPEG1 compliant (Monaural)
Recording media: Internal Memory (approx.
31 MB), "Memory Stick Duo"
Flash: Flash range (ISO sensitivity
(Recommended Exposure
Index) set to Auto): approx. 0.1 to 3.0 m
(4 inches to 9 feet 10 1/8 inches) (W)/
approx. 0.25 to 2.5 m (9 7/8 inches to
8 feet 2 1/2 inches) (T)

[Input and Output connectors]

Multi connector : Video output
Audio output (Monaural)
USB communication
USB communication : Hi-Speed USB (USB 2.0
compliant)

[LCD screen]

LCD panel: Wide (16:9), 7.5 cm (3.0 type) TFT drive
Total number of dots: 230 400 (960×240) dots

[Power, general]

Power: Rechargeable battery pack NP-BD1, 3.6 V
NP-FD1 (not supplied), 3.6 V
AC-LS5K AC Adaptor (not supplied), 4.2 V
Power consumption (during shooting): 1.0 W
Operating temperature: 0 to 40 °C (32 to 104 °F)
Storage temperature: –20 to +60 °C (–4 to +140 °F)
Dimensions: 90.0×56.4×20.7 mm (3 5/8×
2 1/4×27/32 inches) (W/H/D, excluding
protrusions)
Mass (including NP-BD1 battery pack, paint pen
and strap etc.): Approx. 156 g (5.5 oz)
Microphone: Monaural
Speaker: Monaural
Exif Print: Compatible
PRINT Image Matching III: Compatible
PictBridge: Compatible

BC-CSD battery charger

Power requirements: AC 100 V to 240 V, 50/60 Hz,
2.2 W
Output voltage: DC 4.2 V, 0.33 A
Operating temperature: 0 to 40 °C (32 to 104 °F)
Storage temperature: –20 to +60 °C (–4 to +140 °F)
Dimensions: Approx. 62×24×91 mm (2 1/2×
31/32×3 5/8 inches) (W/H/D)
Mass: Approx. 75 g (2.7 oz)

Rechargeable battery pack NP-BD1

Used battery: Lithium-ion battery
Maximum voltage: DC 4.2 V
Nominal voltage: DC 3.6 V
Capacity: 2.4 Wh (680 mAh)

Design and specifications are subject to change
without notice.

Model information table

Model	DSC-T70	DSC-T75
Destination	US, CND, AEP, UK, E, AUS, HK, CH, KR, AR, BR, J, JE	AEP, UK, E, KR
HD Output Adaptor Cable	×	○

- Abbreviation

- AR : Argentine model
- AUS : Australian model
- BR : Brazilian model
- CH : Chinese model
- CND : Canadian model
- EE : East European model
- HK : Hong Kong model
- J : Japanese model
- JE : Tourist model
- KR : Korea model
- MX : Mexican model
- NE : North European model

CAUTION

Danger of explosion if battery is incorrectly replaced.
Replace only with the same or equivalent type.

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK \triangle OR DOTTED LINE WITH MARK \triangle ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFÉS PAR UNE MARQUE \triangle SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈSES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.

SAFETY CHECK-OUT

After correcting the original service problem, perform the following safety checks before releasing the set to the customer.

1. Check the area of your repair for unsoldered or poorly-soldered connections. Check the entire board surface for solder splashes and bridges.
2. Check the interboard wiring to ensure that no wires are "pinched" or contact high-wattage resistors.
3. Look for unauthorized replacement parts, particularly transistors, that were installed during a previous repair. Point them out to the customer and recommend their replacement.
4. Look for parts which, through functioning, show obvious signs of deterioration. Point them out to the customer and recommend their replacement.
5. Check the B+ voltage to see it is at the values specified.
6. FLEXIBLE Circuit Board Repairing
 - Keep the temperature of the soldering iron around 270°C during repairing.
 - Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
 - Be careful not to apply force on the conductor when soldering or unsoldering.

Unleaded solder

Boards requiring use of unleaded solder are printed with the lead-free mark (LF) indicating the solder contains no lead. (Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size.)



LEAD FREE MARK

Unleaded solder has the following characteristics.

- Unleaded solder melts at a temperature about 40°C higher than ordinary solder.
Ordinary soldering irons can be used but the iron tip has to be applied to the solder joint for a slightly longer time.
Soldering irons using a temperature regulator should be set to about 350°C.
Caution: The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful!
- Strong viscosity
Unleaded solder is more viscous (sticky, less prone to flow) than ordinary solder so use caution not to let solder bridges occur such as on IC pins, etc.
- Usable with ordinary solder
It is best to use only unleaded solder but unleaded solder may also be added to ordinary solder.

1-1. PRECAUTION ON REPLACING THE SY-183 BOARD

DESTINATION DATA

When you replace to the repairing board, the written destination data of repairing board also might be changed to original setting. Refer to Service Manual ADJ, and perform "DESTINATION DATA WRITE".

USB SERIAL No.

The set is shipped with a unique ID (USB Serial No.) written in it.

This ID has not been written in a new board for service, and therefore it must be entered after the board replacement.

Refer to Service Manual ADJ, and perform "USB SERIAL No. INPUT".

1-2. SELF-DIAGNOSIS FUNCTION

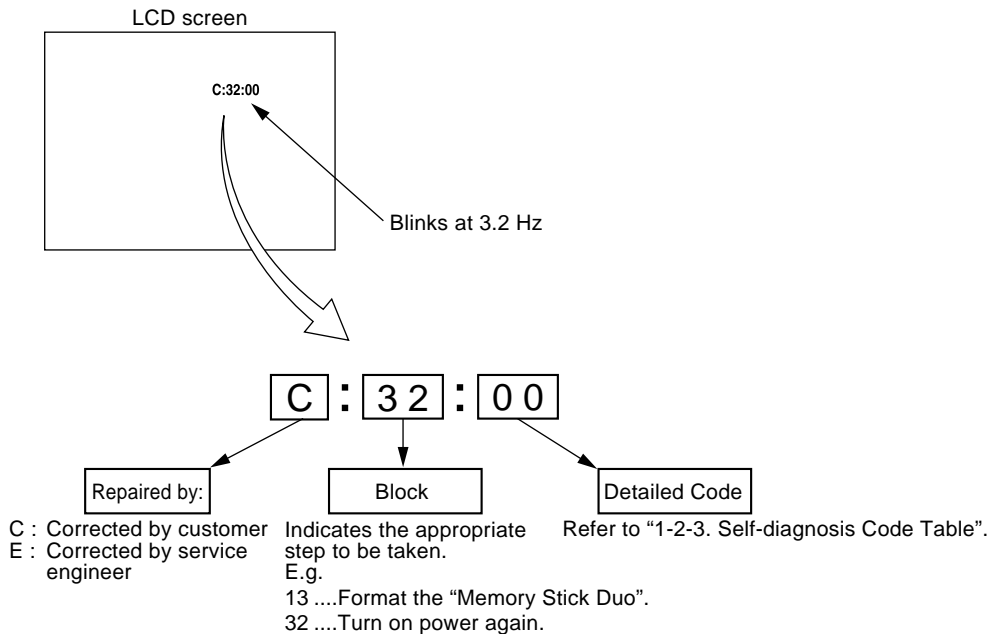
1-2-1. Self-diagnosis Function

When problems occur while the unit is operating, the self-diagnosis function starts working, and displays on the LCD screen what to do.

Details of the self-diagnosis functions are provided in the Instruction manual.

1-2-2. Self-diagnosis Display

When problems occur while the unit is operating, the LCD screen shows a 4-digit display consisting of an alphabet and numbers, which blinks at 3.2 Hz. This 5-character display indicates the "repaired by:", "block" in which the problem occurred, and "detailed code" of the problem.



1-2-3. Self-diagnosis Code Table

Self-diagnosis Code				Symptom/State	Correction
Repaired by:	Block Function	Detailed Code			
C	1 3	0 1		The internal memory has experienced a format error.	Format the internal memory.
				“Memory Stick Duo” is unformatted.	Format the “Memory Stick Duo”.
				“Memory Stick Duo” is broken.	Insert a new “Memory Stick Duo”.
				“Memory Stick Duo” type error	Insert a supported “Memory Stick Duo”.
				The camera cannot read or write data on the “Memory Stick Duo”.	Turn the power off and on again, or taking out and inserting the “Memory Stick Duo” several times.
C	3 2	0 1		Trouble with hardware	Turn the power off and on again.
E	6 1	0 0		Difficult to adjust focus (Cannot initialize focus)	Retry turn the power on by the power switch. If it does not recover, check the focus reset sensor of lens block (pin ㉓ of CN401 on the SY-183 board). If it is OK, check the focus motor drive IC (IC401 on the SY-183 board).
E	6 1	1 0		Zoom operations fault (Cannot initialize zoom lens.)	Retry turn the power on by the power switch. Check the zoom reset sensor of lens block (pin ㉔ of CN401 on the SY-183 board), if zooming is performed when the zoom button is operated. If it is OK, check the zoom motor drive IC (IC401 on the SY-183 board).
E	6 2	0 2		Abnormality of IC for steadyshot.	Check or replacement of the IC for steadyshot (IC503 on the SY-183 board).
E	6 2	1 0		Lens initializing failure.	Check or replacement of the IC for steadyshot (IC503 on the SY-183 board).
E	6 2	1 1		Lens overheating (PITCH).	Check the HALL element (PITCH) of optical image stabilizer (pin ①, ② of CN401 on the SY-183 board). If it is OK, check PITCH angular velocity sensor (SE502 on the SY-183 board) peripheral circuits.
E	6 2	1 2		Lens overheating (YAW).	Check the HALL element (YAW) of optical image stabilizer (pin ⑥, ⑦ of CN401 on the SY-183 board). If it is OK, check YAW angular velocity sensor (SE501 on the SY-183 board) peripheral circuits.
E	6 2	2 0		Abnormality of thermistor.	Check the OIS temp sensor of optical image stabilizer (pin ⑤ of CN401 on the SY-183 board).
E	9 1	0 1		Abnormality when flash is being charged.	Checking of flash unit or replacement of flash unit. (Note)
E	9 2	0 0		Non-standard battery is used.	Use the compatible battery only.

Note: After repair, be sure to perform “1-3. PROCESS AFTER FIXING FLASH ERROR”.

1-3. PROCESS AFTER FIXING FLASH ERROR

When “FLASH error” (Self-diagnosis Code E : 91 : 01) occurs, to prevent any abnormal situation caused by high voltage, setting of the flash is changed automatically to disabling charge and flash setting.

After fixing, this setting needs to be deactivated. Flash error code can be initialized by the operations on the HOME screen.

Method for Initializing the Flash Error Code

Initialize

Initializes the setting to the default setting. Even if you execute this function, the images stored in the internal memory are retained.

- ① Touch [Initialize].
The message “Initialize all settings” appears.
- ② Touch [OK].
The settings are reset to the default setting.

To cancel the resetting

Touch [Cancel] or [BACK] in step ②.

- Make sure that the power is not disconnected during resetting.

1-4. METHOD FOR COPYING OR ERASING THE DATA IN INTERNAL MEMORY

The data can be copied/erased by the operations on the HOME screen. (When erasing the data, execute formatting the internal memory.)

Note 1: When replacing the SY-183 board, erase the data in internal memory of the board before replacement.

Method for Copying the Data in Internal Memory

Copy

Copies all images in the internal memory to a “Memory Stick Duo”.

- ① Insert a “Memory Stick Duo” with sufficient capacity.
- ② Touch [Copy].
The message “All data internal memory will be copied” appears.
- ③ Touch [OK].
Copy starts.

To cancel the copying

Touch [Cancel] or [BACK] in step ③.

- Use a fully charged battery pack. If you attempt to copy image files using a battery pack with little remaining charge, the battery pack may run out, causing copying to fail or possibly corrupting the data.
- You cannot copy individual images.
- The original images in the internal memory are retained even after copying. To delete the contents of the internal memory, remove the “Memory Stick Duo” after copying, then execute the [Format] command in [Internal Memory Tool].
- When you copy the data in the internal memory to the “Memory Stick Duo”, all the data will be copied. You cannot choose a specific folder on the “Memory Stick Duo” as the destination for the data to be copied.
- Even if you copy data, a DPOF (Print order) mark is not copied.

Method for Formatting the Internal Memory

This item does not appear when a “Memory Stick Duo” is inserted in the camera.

Format

Formats the internal memory.

- Note that formatting irrevocably erases all data in the internal memory, including even protected images.

- ① Touch [Format].
The message “All data internal memory will be erased” appears.
- ② Touch [OK].
The format is completed.

To cancel the formatting

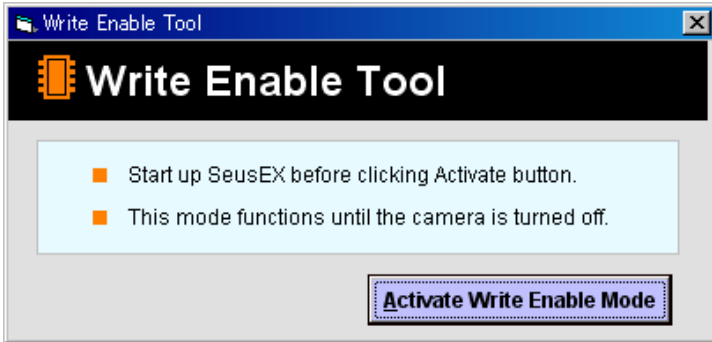
Touch [Cancel] or [BACK] in step ②.

1-5. HOW TO WRITE DATA TO INTERNAL MEMORY

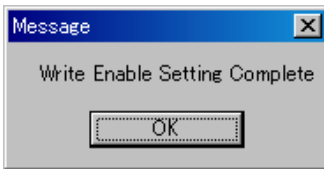
Usually, the camera has been set so as to disable the data writing from the PC to the internal memory of the camera. This setting must be changed temporarily when the data is to be written to the internal memory such as a case after the board replacement. To change the setting, use the write enable tool “WriteEnableTool.exe”.

Data writing method

- 1) Connect the PC to the camera (USB mode: Mass Storage), and switch the driver to the “Sony Seus USB Driver”.
- 2) Start the Write Enable Tool and the SeusEX.
- 3) Click the [Activate Write Enable Mode] button of the Write Enable Tool.



- 4) Upon completion of the setting change, the following message will be displayed.



- 5) Return the driver to the original one, and connect the PC to the camera (USB mode: Mass Storage).
- 6) Write the data read out into the PC to the internal memory of the camera.
- 7) Disconnect the PC from the camera, and turn off the camera.

Note: By turning off the camera, the write enable setting is reset.

1-1. SY-183基板交換時の注意

仕向けデータ

補修用基板と交換する時、補修用基板に書かれている仕向けデータは元の設定と違う場合があります。ADJ編を参照して、「DESTINATION DATA WRITE」を行ってください。

USBシリアルNo.

セットは、1台毎に異なる固有のID (USB Serial No.) を書き込んだ後、出荷されています。新品の補修用基板には、このIDが書き込まれていないので、基板交換後にIDを入力する必要があります。ADJ編を参照して、「USB SERIAL No. INPUT」を行ってください。

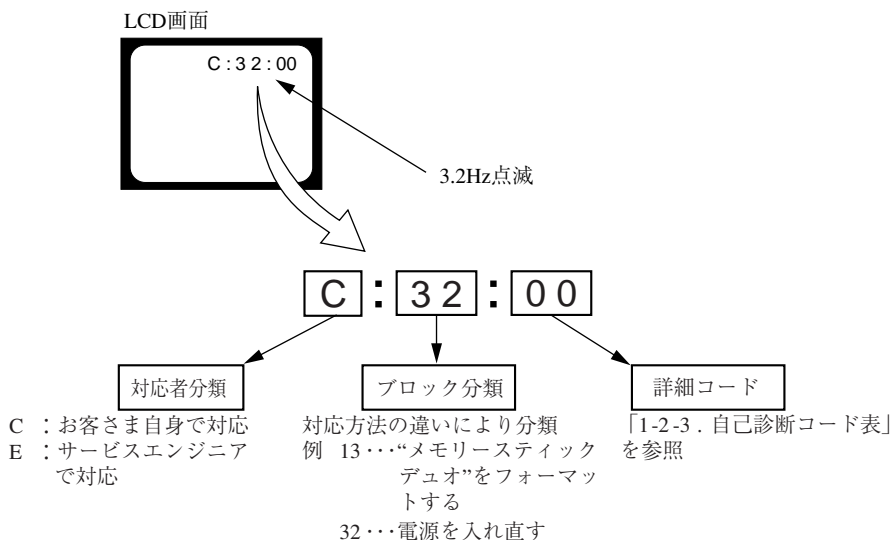
1-2. 自己診断機能

1-2-1. 自己診断機能について

本機の動作に不具合が生じたとき、自己診断機能が働き、LCD画面に、どう処置したらよいか判断できる表示を行います。自己診断機能については取扱説明書にも掲載されています。

1-2-2. 自己診断表示

本機の動作に不具合が生じたとき、LCD画面にアルファベットと4桁の数字が表示され、3.2Hzで点滅します。この5文字の表示によって対応者分類および不具合の生じたブロックの分類、不具合の詳細コードを示します。



1-2-3. 自己診断コード表

自己診断コード			症状／状態	対応／方法
対応者	ブロック機能	詳細コード		
C	1 3	0 1	内蔵メモリにフォーマットエラーがあった。	内蔵メモリをフォーマットする。
			フォーマットしていない“メモリースティック デュオ”を入れた。	“メモリースティック デュオ”をフォーマットする。
			“メモリースティック デュオ”が壊れている。	新しい“メモリースティック デュオ”に交換する。
			“メモリースティック デュオ”のタイプエラーを検出した。	規格内の“メモリースティック デュオ”を挿入する。
			“メモリースティック デュオ”が読み／書きできない。	電源の入れ直し、または“メモリースティック デュオ”の挿し／外しを数回試す。
C	3 2	0 1	ハードウェアトラブルを検出した。	電源を入れ直す。
E	6 1	0 0	フォーカスが合にくい。 (フォーカスの初期化ができない)	操作スイッチの電源を入れ直す。 復帰しない場合はレンズブロックのフォーカスリセットセンサ (SY-183基板CN401 ㉔ピン) を点検する。異常なければフォーカスマータ駆動IC (SY-183基板IC401) を点検する。
E	6 1	1 0	ズーム動作の異常。 (ズームレンズの初期化ができない)	操作スイッチの電源を入れ直す。 ズームボタンを操作したときにズーム動作をすればレンズブロックのズームリセットセンサ (SY-183基板CN401 ㉔ピン) を点検する。異常なければズームモータ駆動IC (SY-183基板IC401) を点検する。
E	6 2	0 2	手振れ補正用ICの異常。	手振れ補正用IC (SY-183基板IC503) を点検または交換する。
E	6 2	1 0	手振れ補正用ICの異常。 (レンズ初期化異常)	手振れ補正用IC (SY-183基板IC503) を点検または交換する。
E	6 2	1 1	レンズオーバーヒート (PITCH)	光学手振れ補正ブロックのホール素子 (PITCH) (SY-183基板CN401 ㉑, ㉒ピン) を点検する。異常なければPITCH角速度センサ (SY-183基板SE502) 周辺の回路を点検する。
E	6 2	1 2	レンズオーバーヒート (YAW)	光学手振れ補正ブロックのホール素子 (YAW) (SY-183基板CN401 ㉑, ㉒ピン) を点検する。異常なければYAW角速度センサ (SY-183基板SE501) 周辺の回路を点検する。
E	6 2	2 0	サーミスタの異常。	光学手振れ補正ブロックのサーミスタ (SY-183基板CN401 ㉑ピン) を点検する。
E	9 1	0 1	フラッシュの充電異常。	フラッシュユニットを点検または交換する。(Note)
E	9 2	0 0	規定外の充電電池が使用された。	規定の充電電池を使用する。

Note：交換後は、必ず「1-3. フラッシュ異常修理後の処置」を行って下さい。

1-3. フラッシュエラー発生時の対処法

本機はフラッシュエラー（自己診断コードE：91：01）が発生した場合、高電圧による異常を防止するために自動的にフラッシュ充電および発光禁止の設定になります。

フラッシュエラー発生後はエラーの解除を行う必要があります。エラーの解除はホーム画面から初期化操作を実行することにより行います。

設定リセット

お買い上げ時の設定に戻します。
[設定リセット]を実行しても、内蔵メモリーに記録されている画像は削除されません。

- ① [設定リセット]をタッチする。
[全ての設定内容をリセットします]というメッセージが表示される。
- ② [実行]をタッチする。
設定リセットが実行される。

設定リセットを中止するには

手順②で、[キャンセル]または[BACK]をタッチする。

設定リセット中は電源が切れないようにご注意ください。

1-4. 内蔵メモリーのデータコピーおよび消去方法

内蔵メモリーのデータコピーまたは消去はホーム画面の操作から実行可能です。（消去する場合は内蔵メモリーの初期化を行います。）

Note1：SY-183基板交換の際は、基板交換前に内蔵メモリーのデータを消去して下さい。

内蔵メモリーのコピー方法

コピー

内蔵メモリーに記録した画像を、“メモリースティック デュオ”に一括コピーします。

- ① 十分な空き容量のある“メモリースティックデュオ”を本体に入れる。
- ② [コピー]をタッチする。
「内蔵メモリーのデータがすべてコピーされます」というメッセージが表示される。
- ③ [実行]をタッチする。
コピーが実行される。

コピーを中止するには

手順③で、[キャンセル]または[BACK]をタッチする。

- ・十分に充電したバッテリーをご使用ください。残量の少ないバッテリーを使用して画像ファイルをコピーすると、バッテリー切れのため、データを転送できなかったり、データを破損するおそれがあります。
- ・画像ごとのコピーはできません。
- ・データをコピーしても、内蔵メモリー内のデータは削除されません。内蔵メモリーの内容を消去するには、コピー後に“メモリースティック デュオ”を本体から取りはずし、[内蔵メモリーツール]の[フォーマット]を行ってください。
- ・データのコピーをすると、“メモリースティックデュオ”内に新しいフォルダが作成されます。コピー先のフォルダを指定することはできません。
- ・データのコピーを行っても、DPOF（プリント予約）マークの設定はコピーされません。

内蔵メモリーのフォーマット方法

“メモリースティック デュオ”が本機に入っている場合は表示されません。

フォーマット

内蔵メモリーの管理領域をフォーマット(初期化)します。

フォーマットすると、プロテクトしてある画像も含めて、すべてのデータが消去され、元に戻せません。

- ① [フォーマット]をタッチする。
「内蔵メモリーのデータがすべて消去されます」というメッセージが表示される。
- ② [実行]をタッチする。

フォーマットを中止するには

手順②で、[キャンセル]または[BACK]をタッチする。

1-5. 内蔵メモリヘータを書き戻す方法

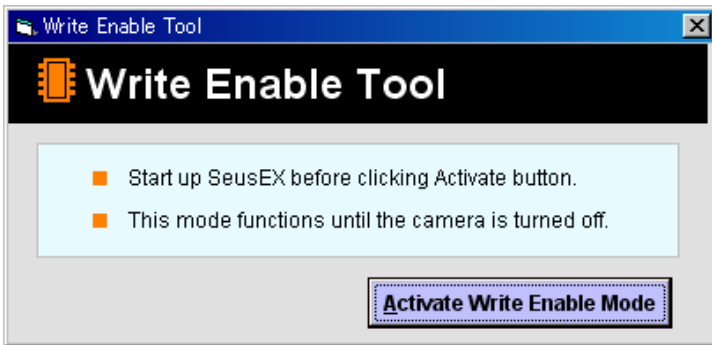
通常は、PCからカメラの内蔵メモリヘータを書き込むことはできない設定になっています。

基板交換後などに、内蔵メモリヘータを書き戻す場合には、この設定を一時的に変更する必要があります。

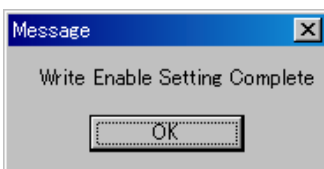
設定の変更には、書き込み許可ツール (WriteEnableTool.exe) を使用します。

書き戻し方法

- 1) カメラとPCをマストレージ接続し、ドライバを "Sony Seus USB Driver" に切り替える。
- 2) 書き込み許可ツールとSeusEXを起動する。
- 3) 書き込み許可ツールの **Activate Write Enable Mode** ボタンをクリックする。



- 4) 設定の変更が終了すると、次のメッセージが表示されます。



- 5) ドライバを元に戻して、カメラとPCをマストレージ接続する。
- 6) PCに読み出しておいたデータをカメラの内蔵メモリに書き込む。
- 7) カメラとPCの接続を解除し、カメラの電源をOFFにする。

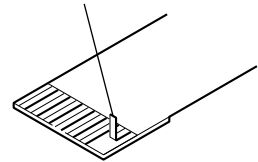
注意：カメラの電源をOFFにすることにより、書き込み許可の設定が解除されます。

2. DISASSEMBLY

NOTE FOR REPAIR

- Make sure that the flat cable and flexible board are not cracked or bent at the terminal.
Do not insert the cable insufficiently nor crookedly.
- When remove a connector, don't pull at wire of connector. It is possible that a wire is snapped.
- When installing a connector, don't press down at wire of connector.
It is possible that a wire is snapped.
- Do not apply excessive load to the gilded flexible board.

Cut and remove the part of gilt which comes off at the point.
(Be careful or some pieces of gilt may be left inside)



DISCHARGING OF THE ST-172 BOARD'S CHARGING CAPACITORS (C901, C902)

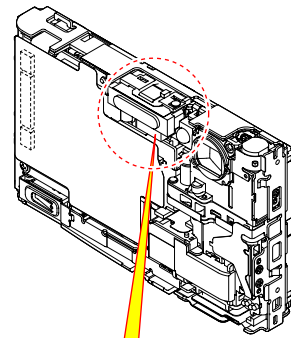
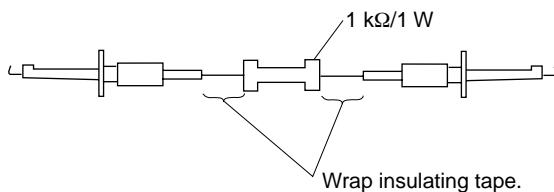
The charging capacitors (C901, C902) of the ST-172 board is charged up to the maximum 315 V potential.

There is a danger of electric shock by this high voltage when the capacitor is handled by hand. The electric shock is caused by the charged voltage which is kept without discharging when the main power of the unit is simply turned off. Therefore, the remaining voltage must be discharged as described below.

Preparing the Short Jig

To preparing the short jig, a small clip is attached to each end of a resistor of 1 k Ω / 1 W (1-215-869-11).

Wrap insulating tape fully around the leads of the resistor to prevent electrical shock.

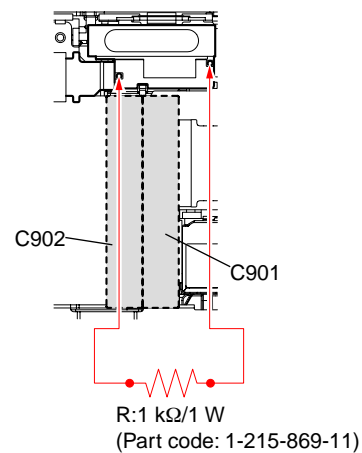


Note: High-voltage cautions

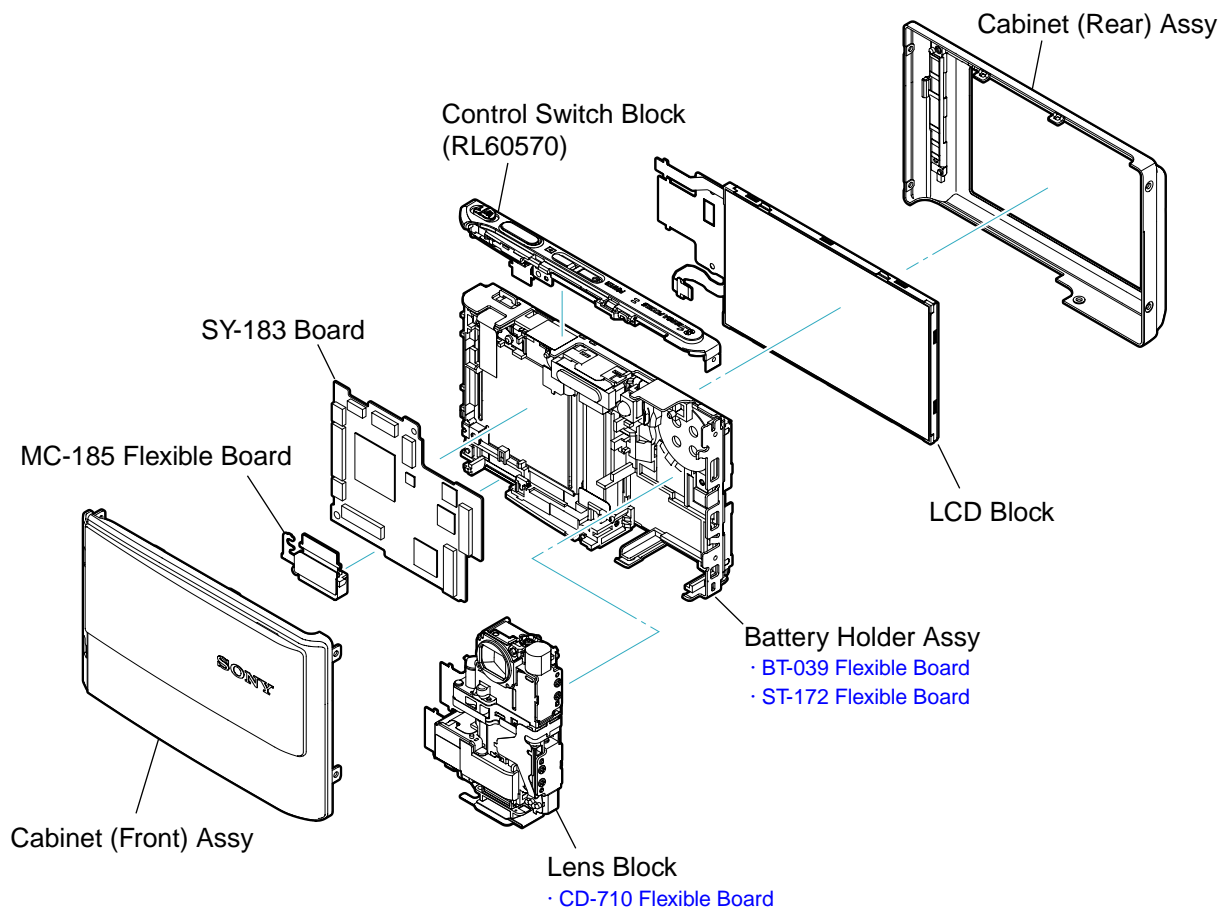
Discharging the Capacitor

Short-circuit between the two points with the short jig about 10 seconds.

To avoid the spark with the metal plate, wrap the short jig with the insulation tape.



2-1. IDENTIFYING PARTS



- DISASSEMBLY FLOW -

2-2-1. OVERALL SECTION

- Cabinet (Front) Assy
- Cabinet (Rear) Assy
- LCD Block

2-2-2. SY-183 BOARD SECTION

- Lens Block
- MC-185 Flexible Board
- SY-183 Board

2-2-3. BATTERY HOLDER SECTION

- Flash Block
- BT-039 Flexible Board
- Battery Holder Assy

2-2. DISASSEMBLY

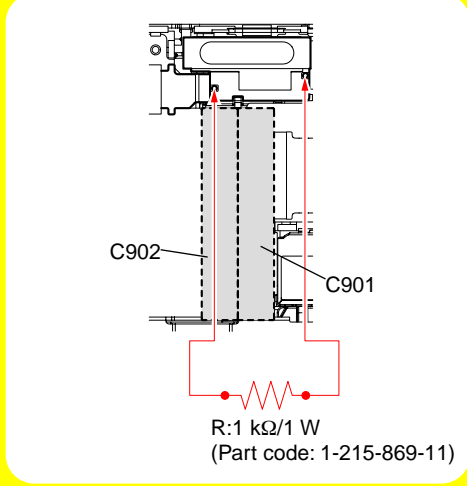
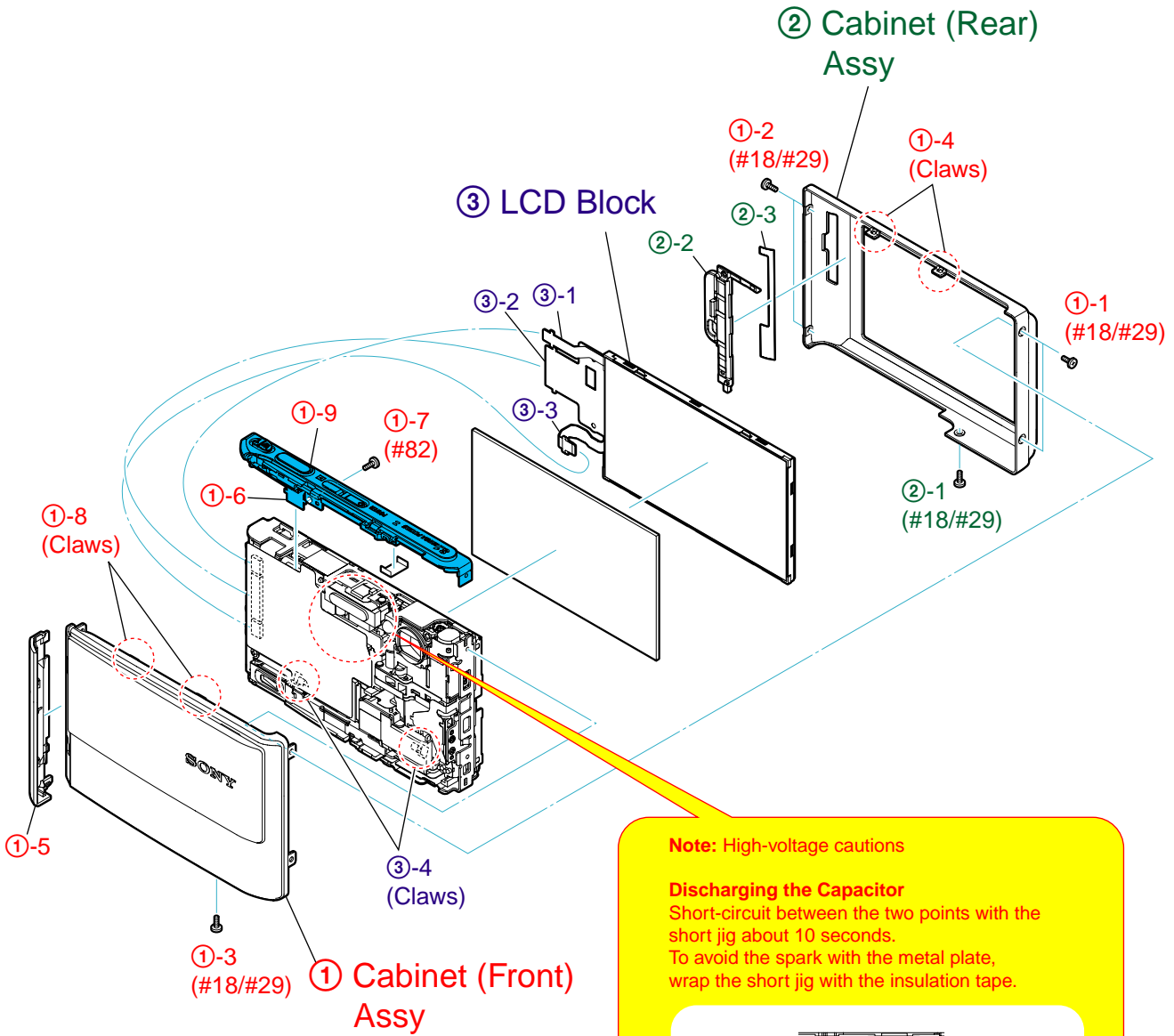
EXPLODED VIEW

HARDWARE LIST

2-2-1. OVERALL SECTION

Follow the disassembly in the numerical order given.

- ① Cabinet (Front) Assy (①-1 to ①-9)
- ② Cabinet (Rear) Assy (②-1 to ②-3)
- ③ LCD Block (③-1 to ③-4)



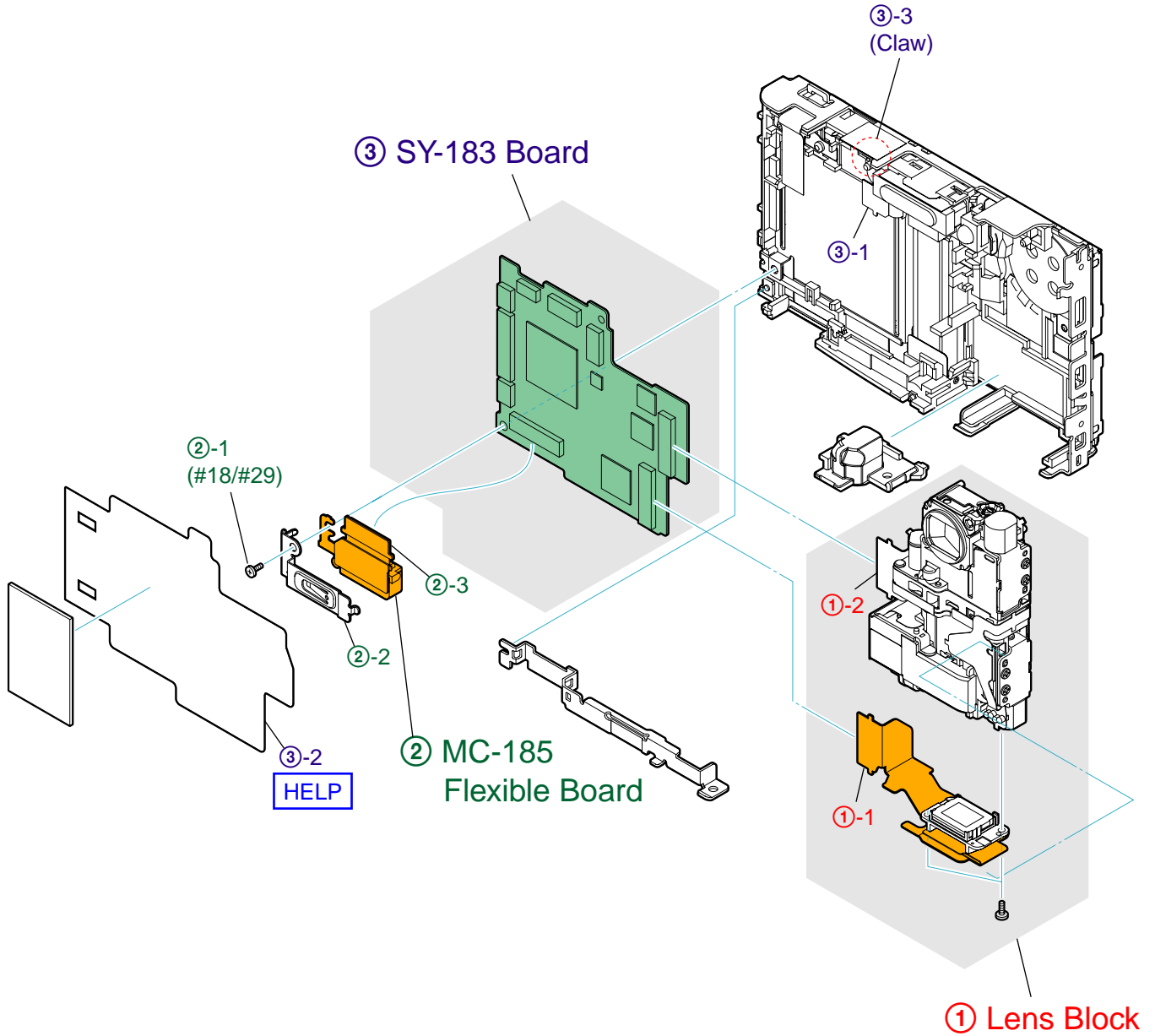
2-2-2. SY-183 BOARD SECTION

Follow the disassembly in the numerical order given.

- ① Lens Block (①-1 to ①-2)
- ② MC-185 Flexible Board (②-1 to ②-3)
- ③ SY-183 Board (③-1 to ③-3)

EXPLODED VIEW

HARDWARE LIST

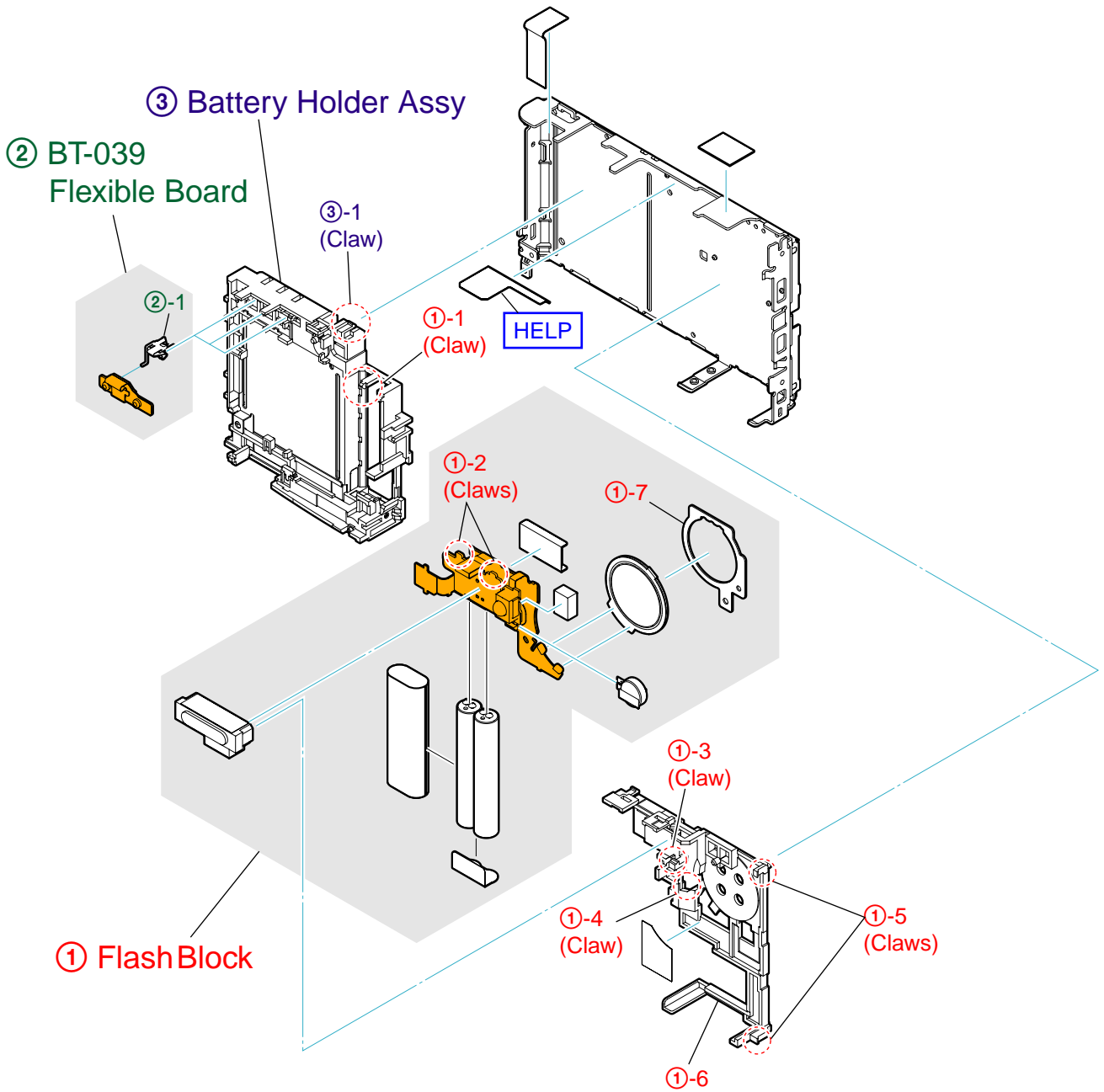


2-2-3. BATTERY HOLDER SECTION

Follow the disassembly in the numerical order given.

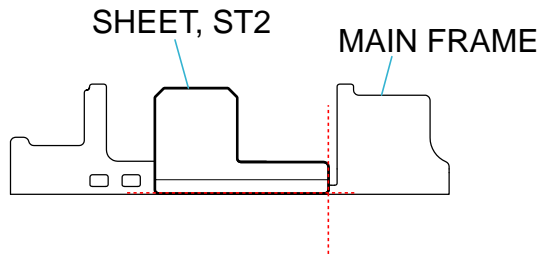
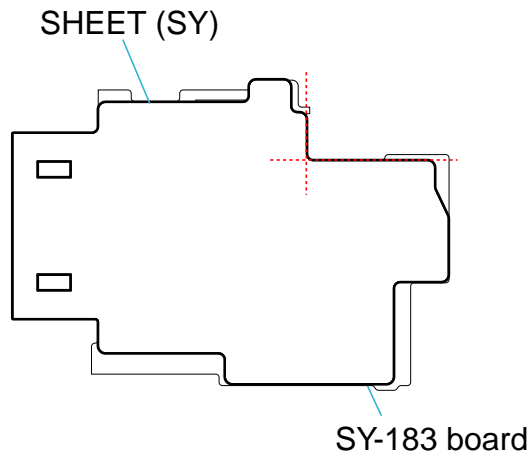
- ① Flash Block (①-1 to ①-7)
- ② BT-039 Flexible Board (②-1)
- ③ Battery Holder Assy (③-1)

EXPLODED VIEW



HELP

Sheet attachment positions and procedures of processing the flexible boards/harnesses are shown.



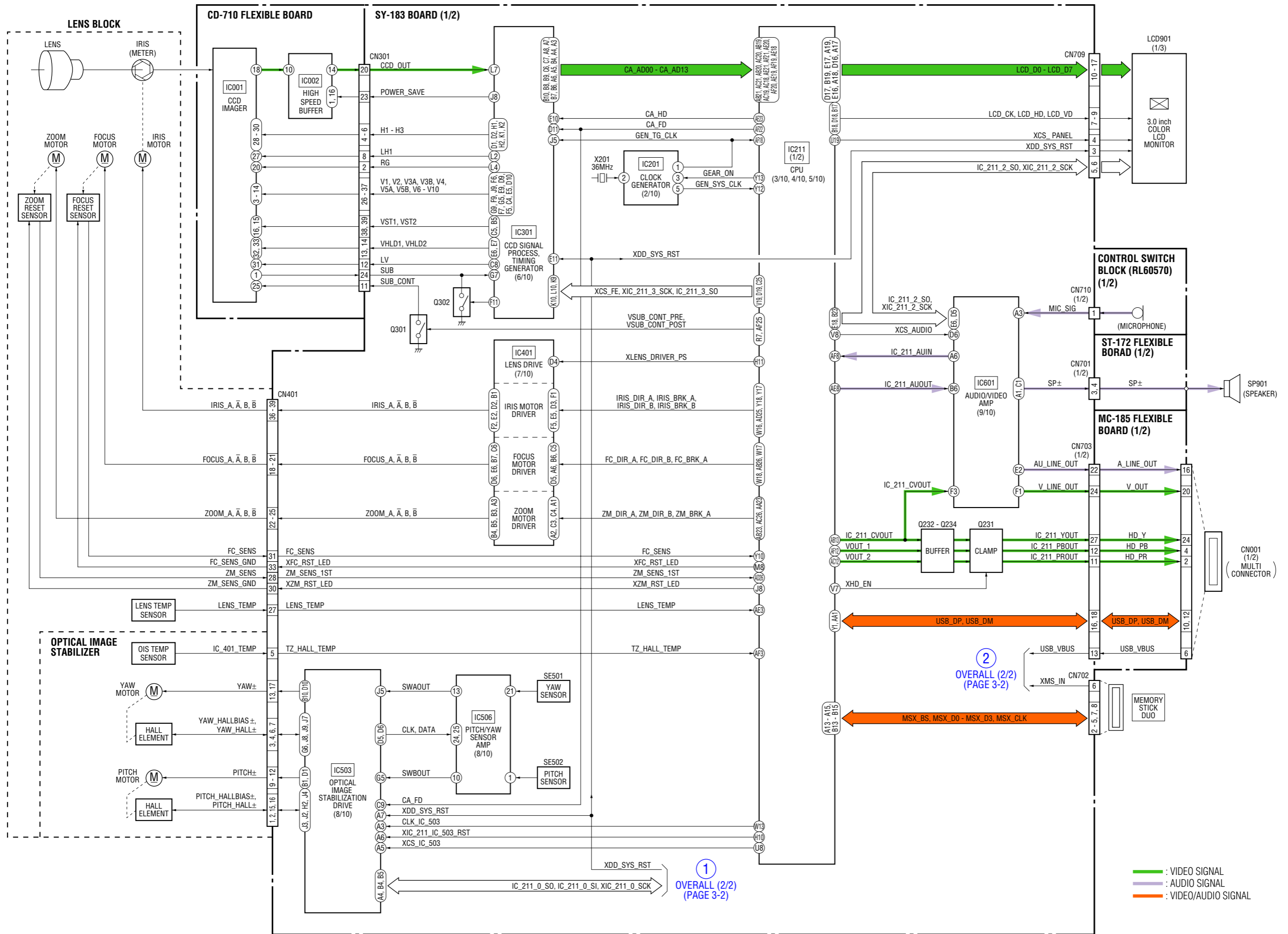
3. BLOCK DIAGRAMS

Link

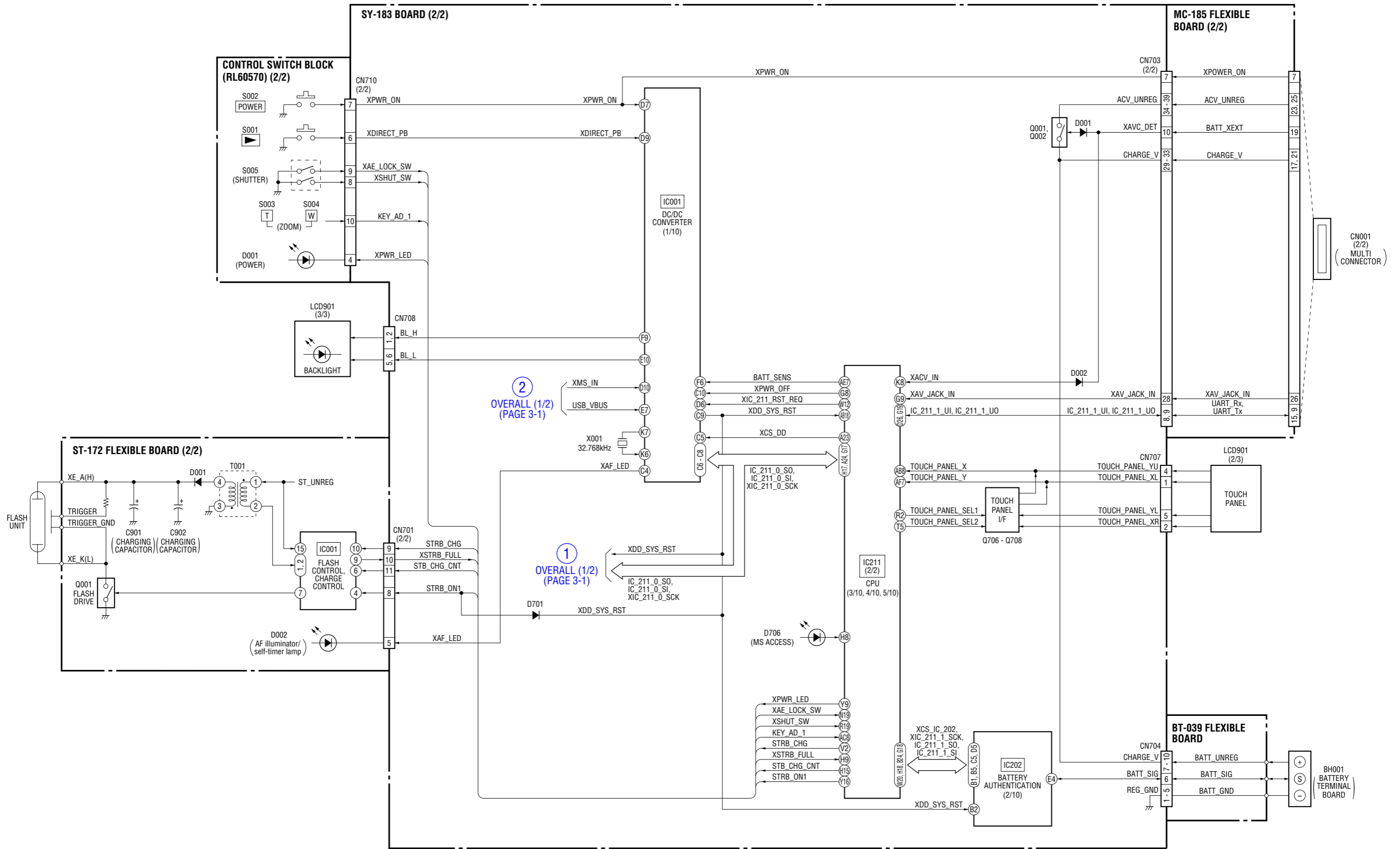
OVERALL BLOCK DIAGRAM (1/2)	POWER BLOCK DIAGRAM (1/2)
OVERALL BLOCK DIAGRAM (2/2)	POWER BLOCK DIAGRAM (2/2)

3. BLOCK DIAGRAMS

3-1. OVERALL BLOCK DIAGRAM (1/2) () : Number in parenthesis () indicates the division number of schematic diagram where the component is located.

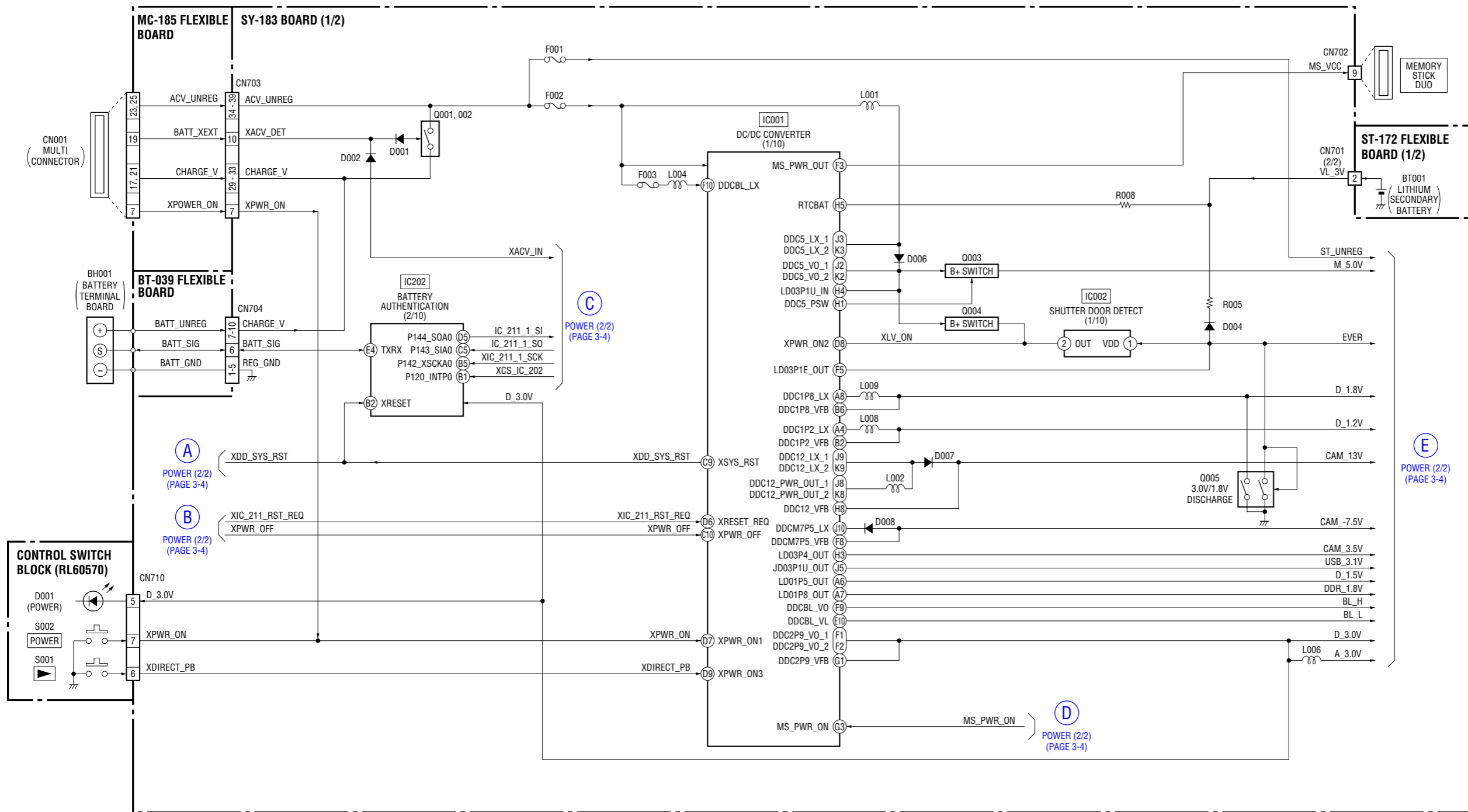


3-2. OVERALL BLOCK DIAGRAM (2/2) () : Number in parenthesis () indicates the division number of schematic diagram where the component is located.



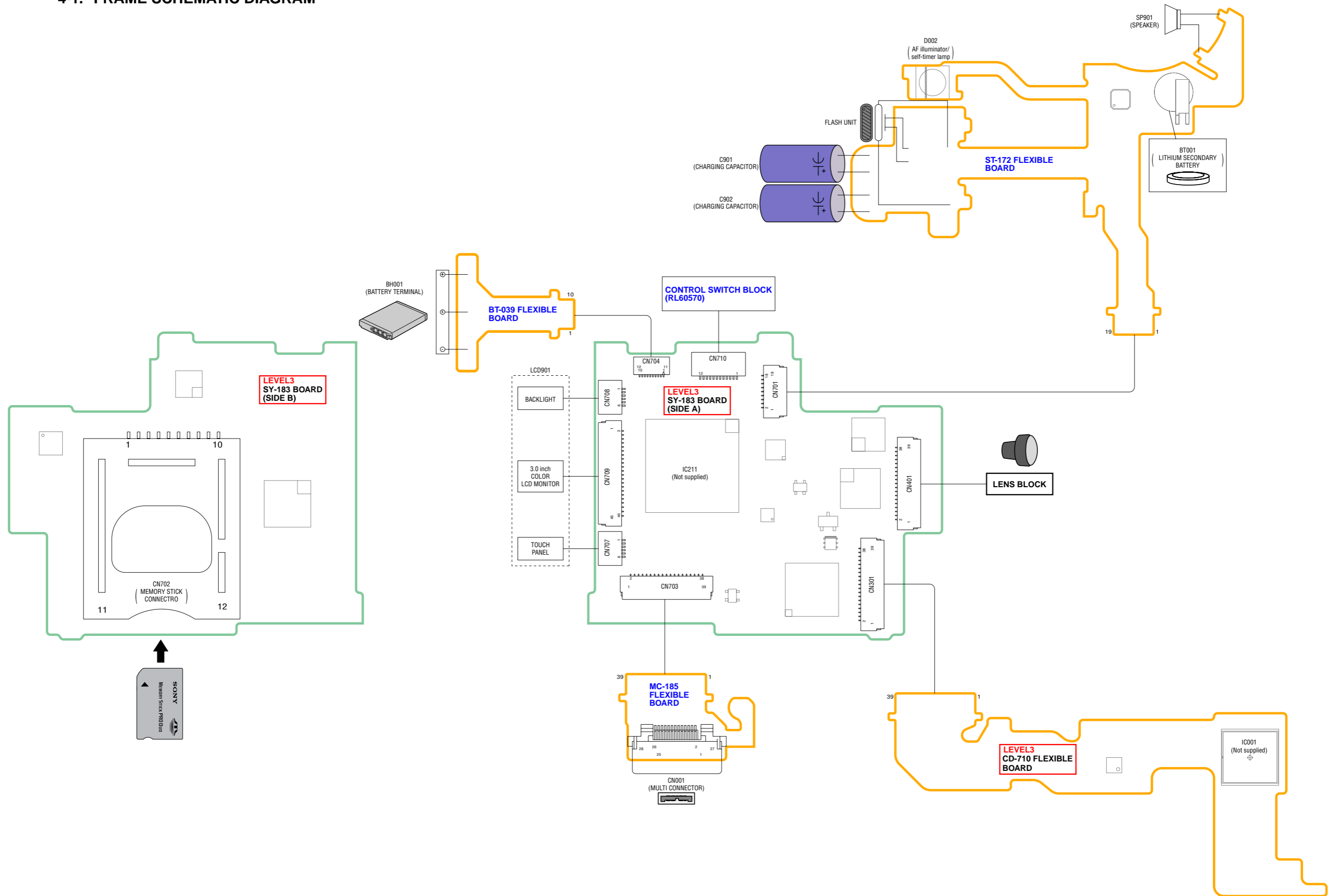
3-3. POWER BLOCK DIAGRAM (1/2)

() : Number in parenthesis () indicates the division number of schematic diagram where the component is located.



4. PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

4-1. FRAME SCHEMATIC DIAGRAM



4-2. SCHEMATIC DIAGRAMS

Link

<ul style="list-style-type: none">• MC-185 FLEXIBLE BOARD (MULTI CONNECTOR)	<ul style="list-style-type: none">• CONTROL SWITCH BLOCK (RL60570)
<ul style="list-style-type: none">• BT-039 FLEXIBLE BOARD (BATTERY IN)	<ul style="list-style-type: none">• ST-172 FLEXIBLE BOARD (FLASH DRIVE)
<ul style="list-style-type: none">• COMMON NOTE FOR SCHEMATIC DIAGRAMS	

4-2. SCHEMATIC DIAGRAMS

4. PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

4-2. SCHEMATIC DIAGRAMS

THIS NOTE IS COMMON FOR SCHEMATIC DIAGRAMS
(In addition to this, the necessary note is printed in each block)

(For schematic diagrams)

- All capacitors are in μF unless otherwise noted. pF : μF . 50 V or less are not indicated except for electrolytics and tantalums.
- Chip resistors are 1/10 W unless otherwise noted. $\text{k}\Omega=1000 \Omega$, $\text{M}\Omega=1000 \text{k}\Omega$.
- Caution when replacing chip parts.
New parts must be attached after removal of chip.
Be careful not to heat the minus side of tantalum capacitor, Because it is damaged by the heat.
- Some chip part will be indicated as follows.

	C541	L452	
	22U	10UH	
	TA A	2520	
Kinds of capacitor			External dimensions (mm)
			Case size

- Constants of resistors, capacitors, ICs and etc with XX indicate that they are not used.
In such cases, the unused circuits may be indicated.
- Parts with ★ differ according to the model/destination. Refer to the mount table for each function.
- All variable and adjustable resistors have characteristic curve B, unless otherwise noted.
- Signal name
XEDIT → EDIT PB/XREC → PB/REC
- : non flammable resistor
- : fusible resistor
- : panel designation
- : B+ Line
- : B- Line
- : IN/OUT direction of (+,-) B LINE.
- : adjustment for repair.
- : not use circuit

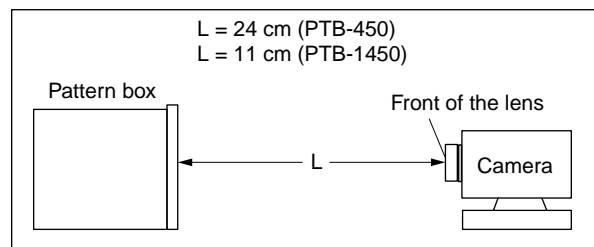
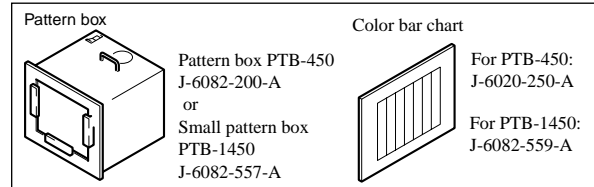
(Measuring conditions voltage and waveform)

- Voltages and waveforms are measured between the measurement points and ground when camera shoots color bar chart of pattern box. They are reference values and reference waveforms.
(VOM of DC 10 M Ω input impedance is used)
- Voltage values change depending upon input impedance of VOM used.)

Precautions for Replacement of Imager

- If the imager has been replaced, carry out all the adjustments for the camera section.
- As the imager may be damaged by static electricity from its structure, handle it carefully like for the MOS IC.
In addition, ensure that the receiver is not covered with dusts nor exposed to strong light.

1. Connection



2. Adjust the distance so that the output waveform of Fig. a and the Fig. b can be obtain.

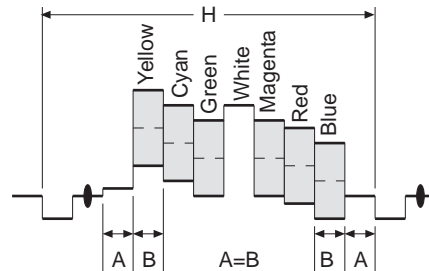


Fig. a (Video output terminal output waveform)

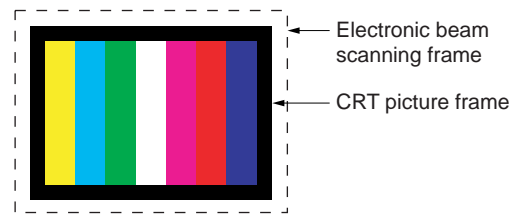


Fig.b (Picture on monitor TV)

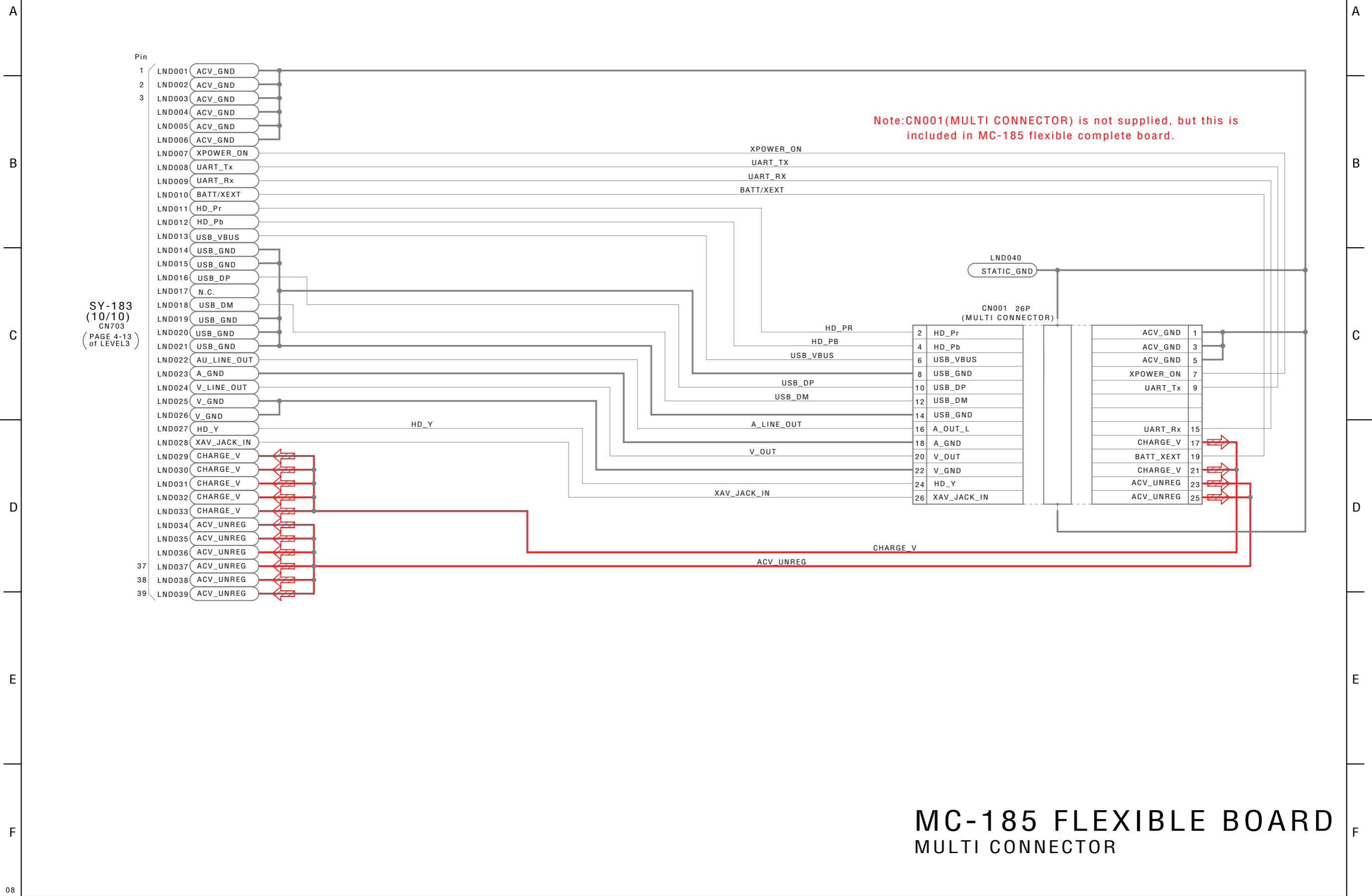
When indicating parts by reference number, please include the board name.

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque \triangle sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

Schematic diagrams of the CD-710 flexible board and the SY-183 board are not shown.
Pages from 4-3 to 4-13 are not shown.

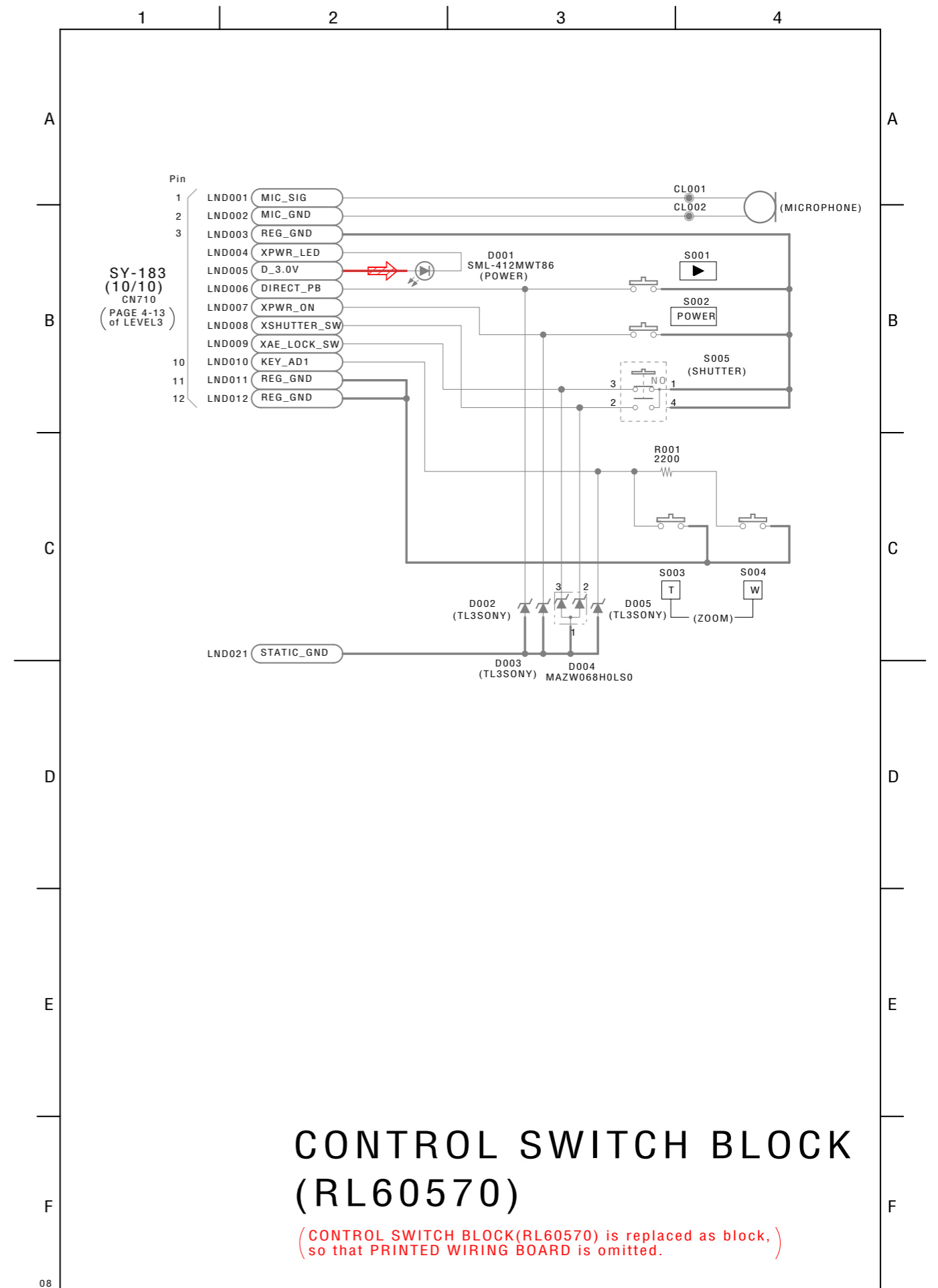
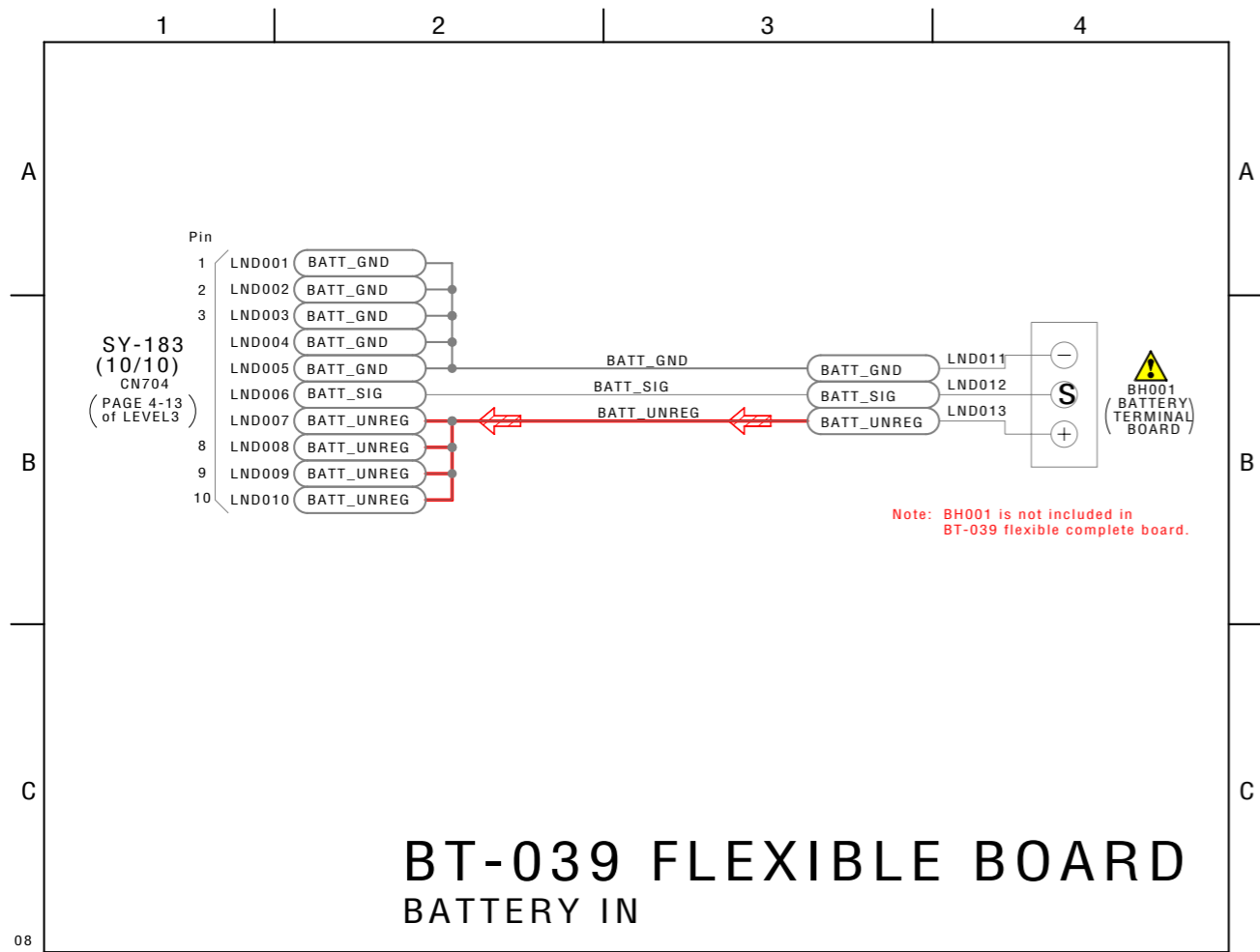
1 2 3 4 5 6 7 8

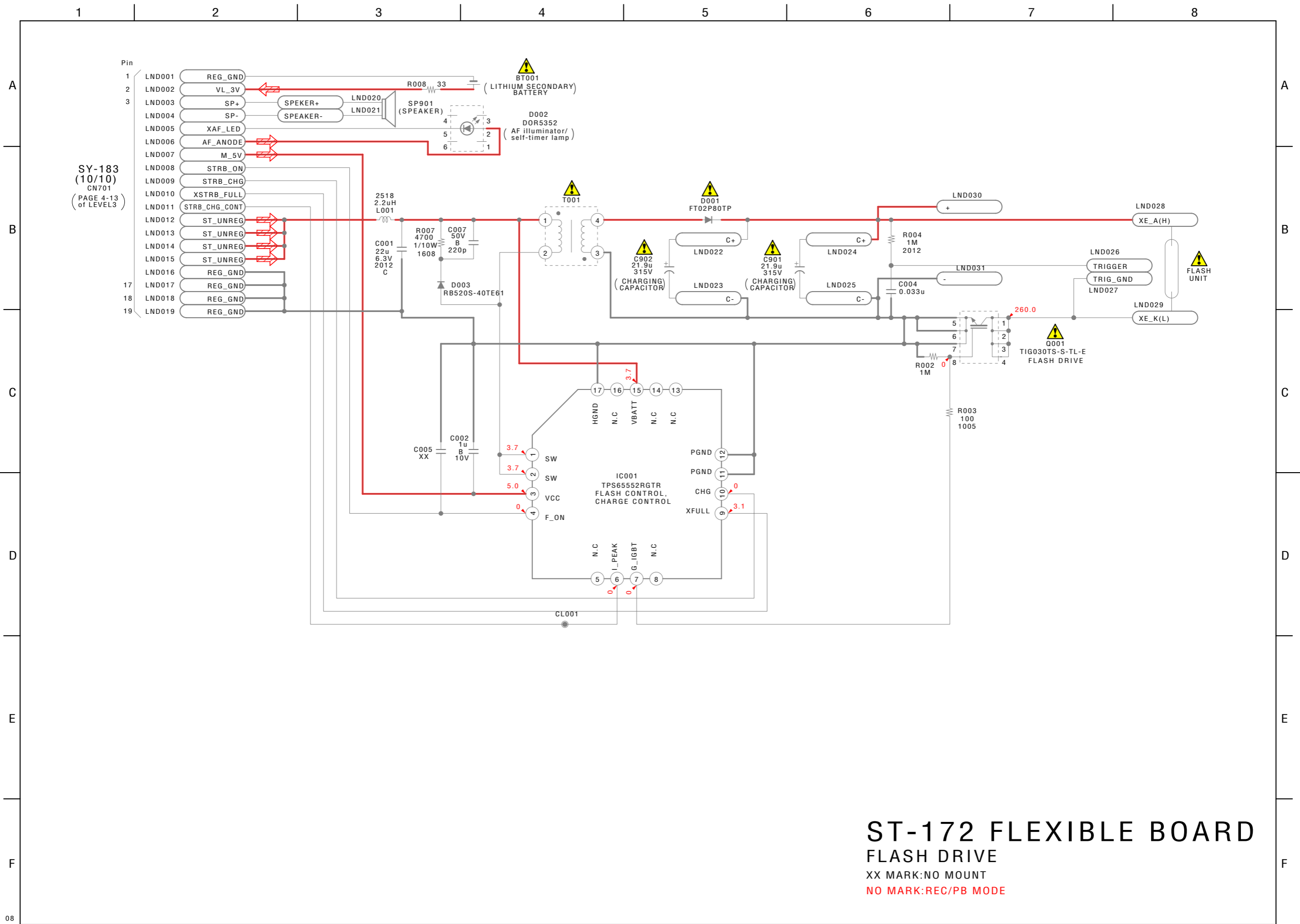


SY-183
(10/10)
CN703
(PAGE 4-13
of LEVEL3)

MC-185 FLEXIBLE BOARD MULTI CONNECTOR

• Refer to page 4-2 for mark △.





4-3. PRINTED WIRING BOARDS

Link

• [MC-185 FLEXIBLE BOARD](#)

• [ST-172 FLEXIBLE BOARD](#)

• [BT-039 FLEXIBLE BOARD](#)

• [COMMON NOTE FOR PRINTED WIRING BOARDS](#)

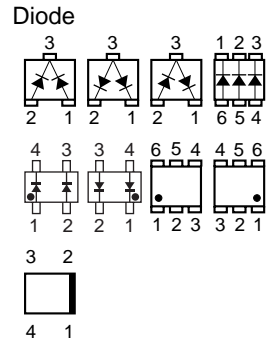
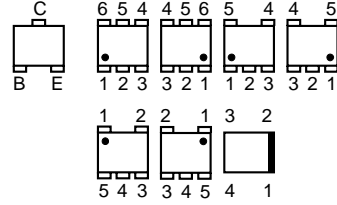
4-3. PRINTED WIRING BOARDS

4-3. PRINTED WIRING BOARDS

THIS NOTE IS COMMON FOR PRINTED WIRING BOARDS

- : Uses unleaded solder.
- : Circuit board
- : Flexible board
- : Pattern from the side which enables seeing.
- : pattern of the rear side
(The other layers' patterns are not indicated)
- Through hole is omitted.
- Circled numbers refer to waveforms.
- There are a few cases that the part printed on diagram isn't mounted in this model.
- : panel designation

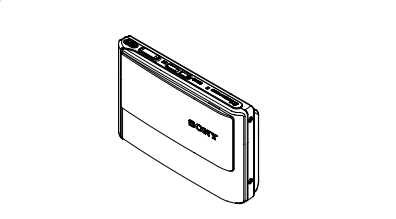
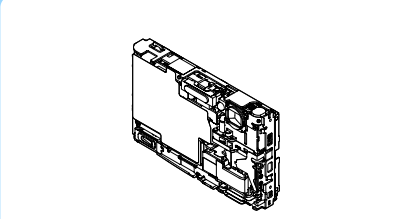
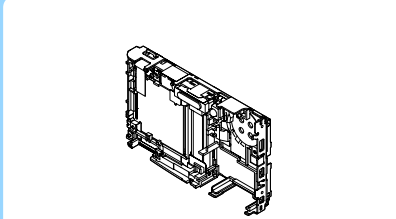
- Chip parts.



Printed wiring boards of the CD-710 flexible board and the SY-183 board are not shown.
Pages 4-18 and 4-20 are not shown.

5. REPAIR PARTS LIST

NOTE: Characters **A** to **Z** of the electrical parts list indicate location of exploded views in which the desired part is shown.

Link	EXPLODED VIEWS		
			
A	B	C	
OVERALL SECTION	SY-183 BOARD SECTION	BATTERY HOLDER SECTION	

Link	ELECTRICAL PARTS LIST	ACCESSORIES
BT-039 FLEXIBLE BOARD C	ST-172 FLEXIBLE BOARD C	
MC-185 FLEXIBLE BOARD B		

5. REPAIR PARTS LIST

5. REPAIR PARTS LIST

NOTE:

- -XX, -X mean standardized parts, so they may have some differences from the original one.
- Items marked "*" are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- CAPACITORS:
 - uF: μ F
- COILS
 - uH: μ H
- RESISTORS
 - All resistors are in ohms.
 - METAL: metal-film resistor
 - METAL OXIDE: Metal Oxide-film resistor
 - F: nonflammable
- SEMICONDUCTORS
 - In each case, u: μ , for example:
 - uA...: μ A..., uPA..., μ PA...,
 - uPB..., μ PB..., μ PC..., μ PC...,
 - uPD..., μ PD...
- Abbreviation
 - AR : Argentine model
 - AUS : Australian model
 - BR : Brazilian model
 - CH : Chinese model
 - CND : Canadian model
 - EE : East European model
 - HK : Hong Kong model
 - J : Japanese model
 - JE : Tourist model
 - KR : Korea model
 - NE : North European model
 - TW : Taiwan model

When indicating parts by reference number, please include the board name.

The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

- Color Indication of Appearance Parts
 - Example:
 - (SILVER) : Cabinet's Color
 - (Silver) : Parts Color

5. REPAIR PARTS LIST

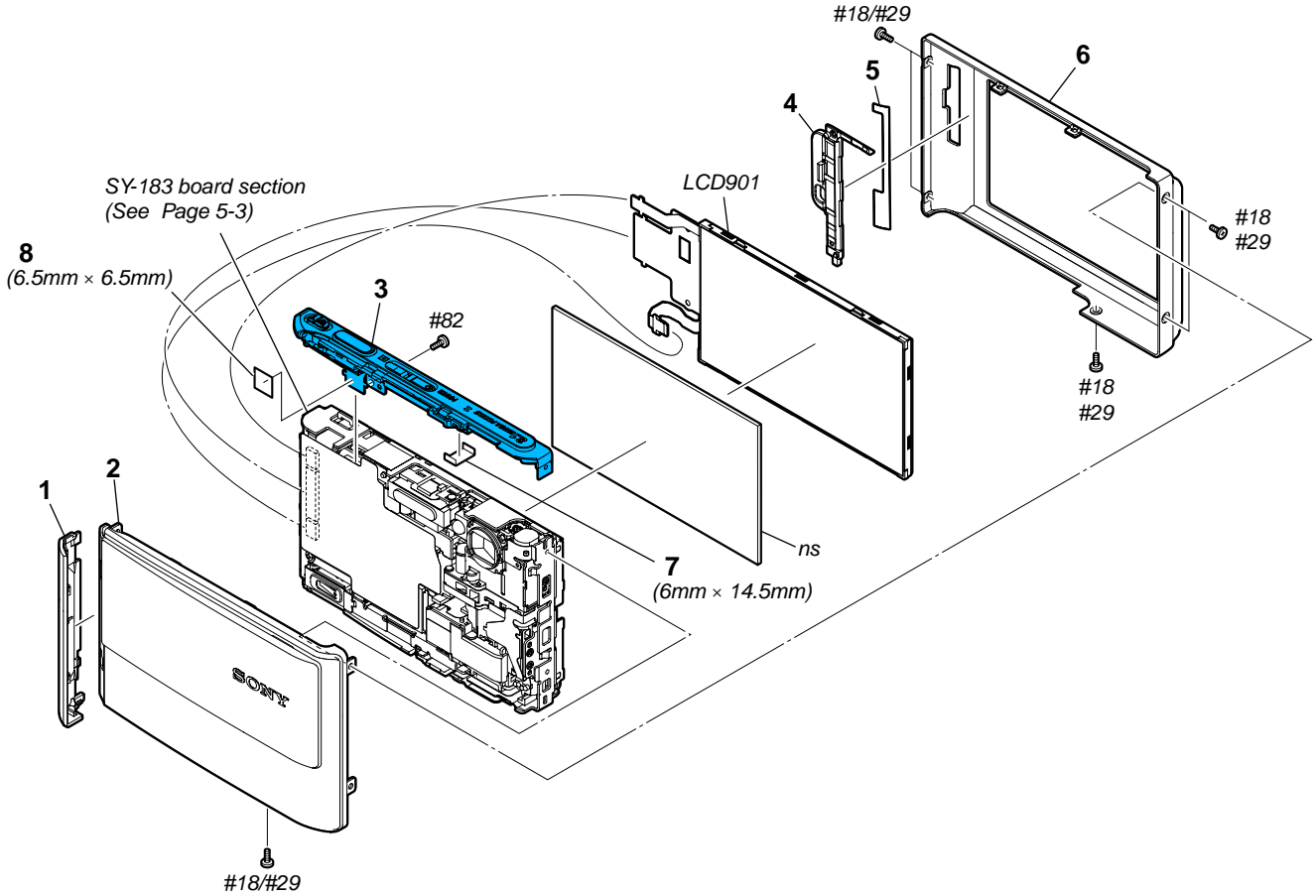
DISASSEMBLY

HARDWARE LIST

5-1. EXPLODED VIEWS

5-1-1. OVERALL SECTION

ns: not supplied



CAUTION 1 :
 For the part of 7 : CUSHION (RL MICROPHONE) (3-275-797-01),
 cut NON WOVEN (T0.25) (3-076-631-01) into the desired length and use it.

CAUTION 2 :
 For the part of 8 : SHEET (WATERPROOF SHEET) (3-280-761-01),
 cut NON WOVEN (T0.25) (3-076-631-01) into the desired length and use it.

Ref. No.	Part No.	Description
1	3-272-252-01	GRIP
2	A-1284-139-A	CABINET (FRONT) BLOCK ASSY (SILVER)
2	A-1284-140-A	CABINET (FRONT) BLOCK ASSY (BLACK)
2	A-1284-141-A	CABINET (FRONT) BLOCK ASSY (WHITE)
2	A-1284-142-A	CABINET (FRONT) BLOCK ASSY (PINK)
3	1-480-344-11	SWITCH BLOCK, CONTROL (RL60570)
4	3-272-254-01	BRACKET, STRAP
* 5	3-272-255-01	SHEET (STRAP), ADHESIVE
6	3-272-253-01	CABINET (REAR (SKK)) (SILVER)
6	3-274-562-11	CABINET (REAR) (BLACK)

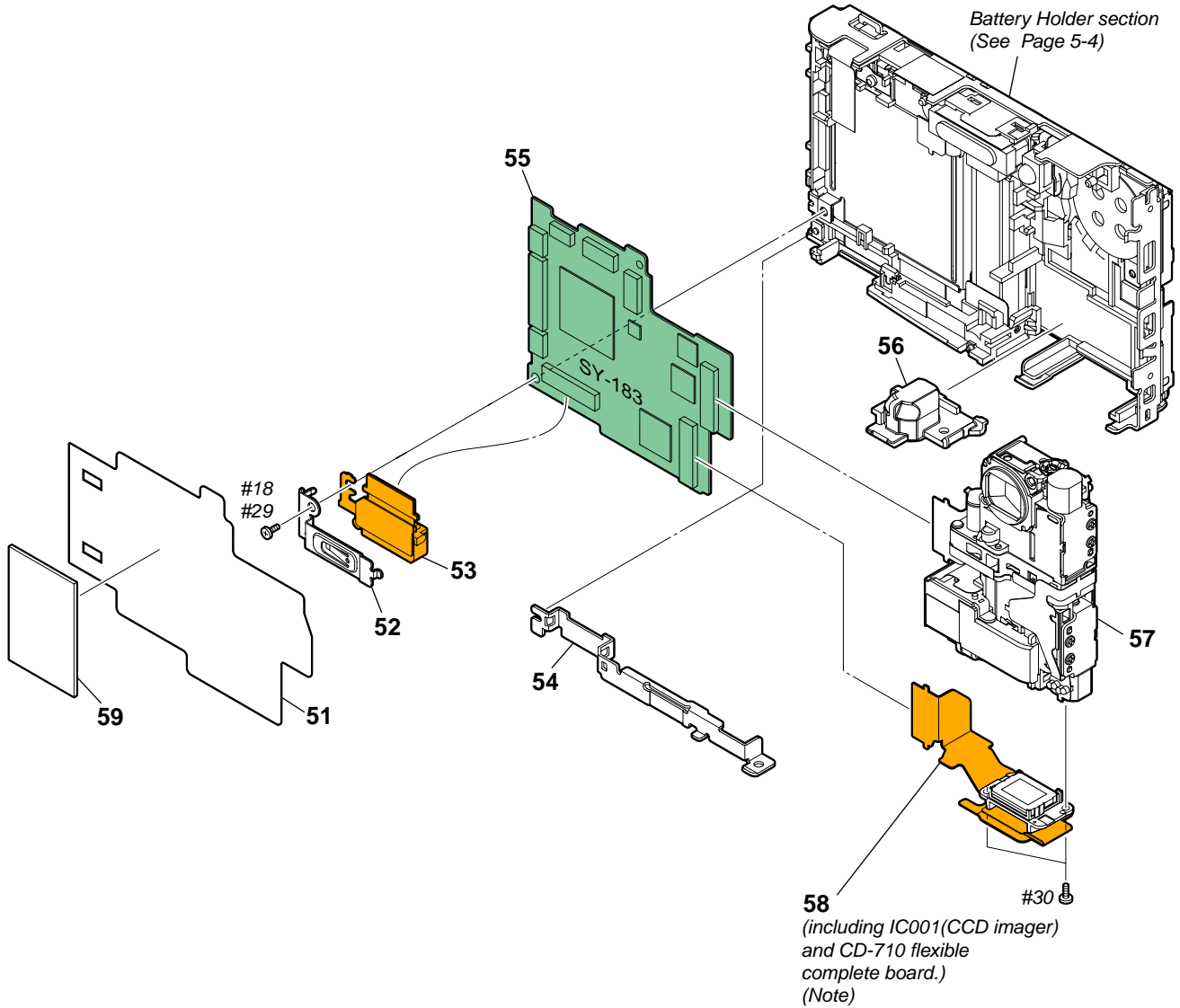
Ref. No.	Part No.	Description
6	3-272-253-21	CABINET (REAR (SKK)) (WHITE)
6	3-272-253-31	CABINET (REAR (SKK)) (PINK)
7	CAUTION 1	CUSHION (RL MICROPHONE)
8	CAUTION 2	SHEET (WATERPROOF SHEET)
LCD901	A-1334-750-A	FTS BLOCK ASSY (30SHGU07)
#18	2-635-591-21	SCREW (M1.4), NEW TRUSTAR P2 (Silver)
#29	2-662-396-01	SCREW (M1.4), NEW, TRUSTAR, P2 (Black)
#82	3-272-251-01	SCREW (M1.4), HEAD PRECISION (Silver)

5. REPAIR PARTS LIST

DISASSEMBLY

HARDWARE LIST

5-1-2. SY-183 BOARD SECTION



Note : Be sure to read "Precautions for Replacement of Imager" on page 4-2.

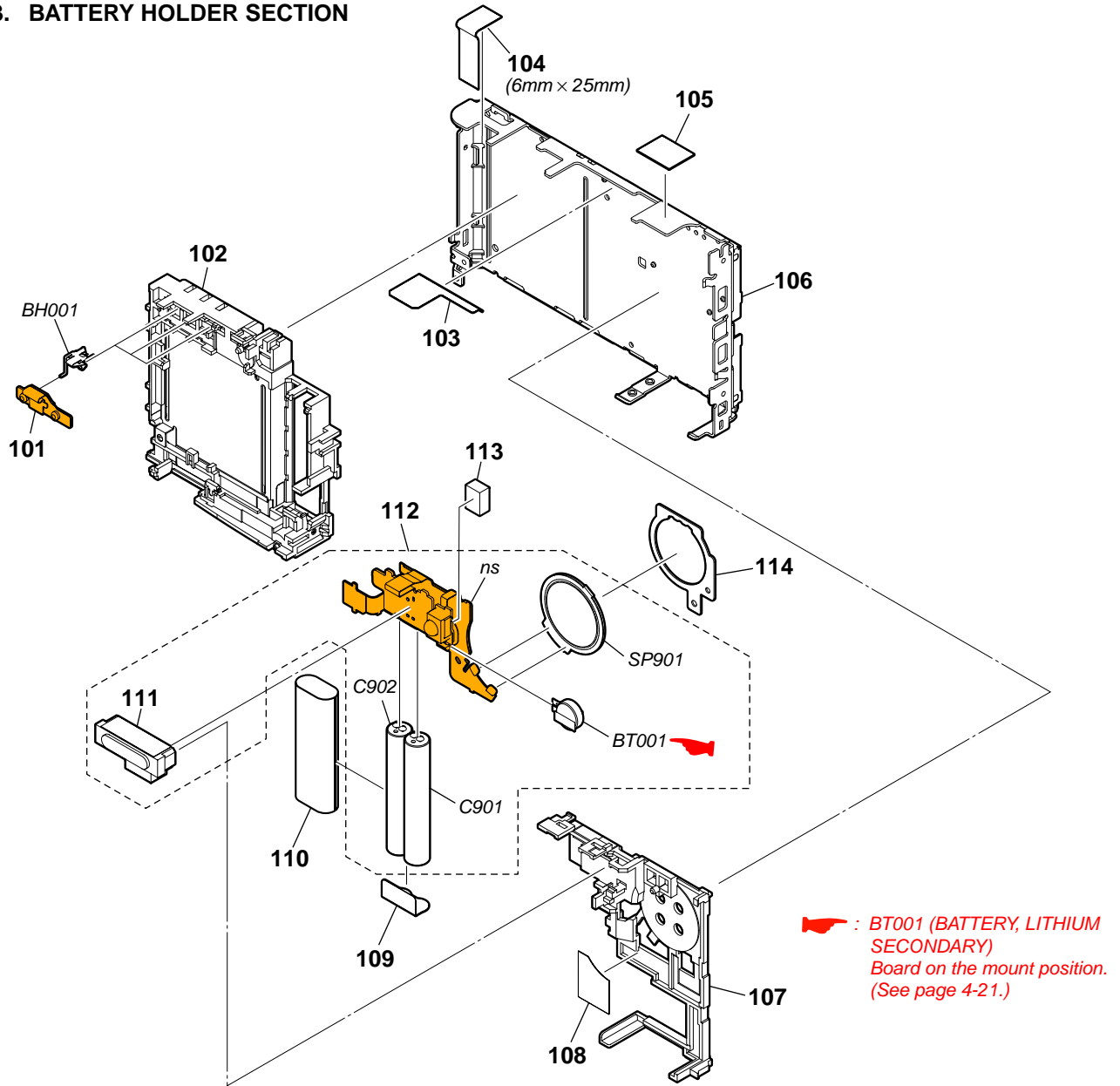
Ref. No.	Part No.	Description
51	3-272-209-01	SHEET (SY)
* 52	3-272-205-01	MULTI (2), PLATE
53	A-1334-225-A	MC-185 FLEXIBLE BOARD, COMPLETE
* 54	3-272-204-01	MULTI (1), PLATE
55	A-1364-520-A	SY-183 BOARD, COMPLETE (SERVICE)
56	3-272-203-01	SCREW, TRIPOD
57	A-1167-020-B	LSV-1110A (SERVICE USE)

Ref. No.	Part No.	Description
58	A-1284-148-A	CCD BLOCK ASSY (including IC001 (CCD imager) and CD-710 flexible complete board.) (Note)
* 59	3-272-428-01	SHEET, ELECTROSTATIC
#18	2-635-591-21	SCREW (M1.4), NEW TRUSTAR P2 (Silver)
#29	2-662-396-01	SCREW (M1.4), NEW, TRUSTAR, P2 (Black)
#30	3-086-156-11	SCREW B1.2 (White)

5. REPAIR PARTS LIST

DISASSEMBLY

5-1-3. BATTERY HOLDER SECTION



CAUTION 1 :
For the part of 104 : SHEET (RL) (3-272-219-01),
cut SHEET, ADHESIVE (2-649-300-01) into the desired length and use it.

CAUTION
Danger of explosion if battery is incorrectly replaced.
Replace only with the same or equivalent type.

• Refer to page 5-1 for mark \triangle .

Ref. No.	Part No.	Description
101	1-874-894-11	BT-039 FLEXIBLE BOARD
102	X-2186-608-1	ASSY, BTH (S) (SILVER)
102	X-2186-609-1	ASSY, BTH (B) (BLACK)
102	X-2186-610-1	ASSY, BTH (W) (WHITE)
102	X-2186-611-1	ASSY, BTH (P) (PINK)
* 103	3-272-216-01	SHEET, ST2
104	CAUTION 1	SHEET (RL)
* 105	3-272-217-01	CUSHION (MICROPHONE)
106	X-2186-606-1	FRAME ASSY, MAIN
107	3-272-206-01	HOLDER, LENS
* 108	3-272-218-01	SHEET, LH

Ref. No.	Part No.	Description
* 109	3-272-210-01	SHEET, MCON
110	3-272-213-01	FILM, ST
\triangle 111	1-480-416-11	FLASH UNIT (FL60570)
112	A-1334-226-A	ST-172 FLEXIBLE BOARD, COMPLETE
* 113	3-272-208-01	CUSHION, AF
* 114	3-272-207-01	CUSHION, SP
* \triangle BT001	1-756-566-11	BATTERY, LITHIUM SECONDARY
\triangle BH001	1-780-456-41	TERMINAL BOARD, BATTERY
* \triangle C901	1-114-572-11	CAP, ELECT 21.9MF 315V
* \triangle C902	1-114-572-11	CAP, ELECT 21.9MF 315V
* SP901	1-826-759-11	BUZZER, PIEZOELECTRIC (2.0CM)

5-2. ELECTRICAL PARTS LIST

<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>
	1-874-894-11	BT-039 FLEXIBLE BOARD *****

(BH001 is not included in BT-039 flexible complete board.)

< BATTERY TERMINAL BOARD >

<u>△</u> BH001	1-780-456-41	TERMINAL BOARD, BATTERY
----------------	--------------	-------------------------

Electrical parts list of the CD-710 flexible board is not shown.
Pages 5-6 is not shown.

• Refer to page 5-1 for mark △.

Ref. No. Part No. Description
 A-1334-225-A MC-185 FLEXIBLE BOARD, COMPLETE

 (CN001 (MULTI CONNECTOR) is not supplied,
 but this is included in MC-185 flexible complete board.)
 < CONNECTOR >
 CN001 (Not supplied) CONNECTOR, MULTIPLE (SOCKET)
 (MULTI CONNECTOR)

A-1334-226-A ST-172 FLEXIBLE BOARD, COMPLETE

△ 1-480-416-11 FLASH UNIT (FL60570)
 < LITHIUM BATTERY SECONDARY >
 *△BT001 1-756-566-11 BATTERY, LITHIUM SECONDARY
 < CAPACITOR >
 C001 1-100-611-91 CERAMIC CHIP 22uF 20% 6.3V
 C002 1-165-908-11 CERAMIC CHIP 1uF 10% 10V
 * C004 1-112-832-21 CERAMIC CHIP 0.033uF 10% 250V
 C007 1-164-933-11 CERAMIC CHIP 220PF 10% 50V
 *△C901 1-114-572-11 CAP, ELECT 21.9uF 315V
 *△C902 1-114-572-11 CAP, ELECT 21.9uF 315V
 < DIODE >
 △D001 6-501-141-01 DIODE FT02P80TP
 * D002 6-501-364-01 DIODE DOR5352
 (AF illuminator/self-timer lamp)
 D003 6-500-619-01 DIODE RB520S-40TE61
 < IC >
 IC001 6-707-555-01 IC TPS65552RGTR
 < COIL >
 * L001 1-400-820-11 INDUCTOR 2.2uH
 < TRANSISTOR >
 *△Q001 6-551-686-01 TRANSISTOR TIG030TS-S-TL-E
 < RESISTOR >
 R002 1-218-989-11 RES-CHIP 1M 5% 1/16W
 R003 1-218-941-11 RES-CHIP 100 5% 1/16W
 R004 1-216-121-00 RES-CHIP 1M 5% 1/10W
 R007 1-216-829-11 METAL CHIP 4.7K 5% 1/10W
 R008 1-218-935-11 RES-CHIP 33 5% 1/16W
 < SPEAKER >
 * SP901 1-826-759-11 BUZZER, PIEZOELECTRIC (2.0CM)
 < TRANSFORMER >
 △T001 1-445-108-21 TRANSFORMER, D.C-D.C CONVERTER

Electrical parts list of the SY-183 board is not shown.
 Pages 5-8 to 5-11 are not shown.

CAUTION
 Danger of explosion if battery is incorrectly replaced.
 Replace only with the same or equivalent type.

• Refer to page 5-1 for mark △.

Checking supplied accessories.

Note 1: This item is supplied with the unit as an accessory, but is not prepared as a service part.



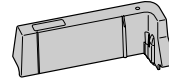
Power cord (mains lead)
(EXCEPT US, CND, BR, J)
 ▲ 1-823-947-71 (KR)
 ▲ 1-827-826-41 (AEP, E)
 ▲ 1-827-945-61 (AUS)
 ▲ 1-828-050-31 (JE)
 ▲ 1-832-106-31 (AR)
 ▲ 1-832-121-31 (CH)
 ▲ 1-832-169-31 (UK, HK)



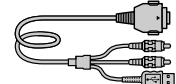
Conversion (2P) Adaptor
 ▲ 1-569-007-12 (JE)



Conversion (2P) Adaptor
 ▲ 1-569-008-12 (E)



Adaptor plate
(HD1-A)
 3-274-257-01



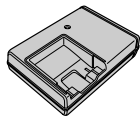
USB, A/V cable for
multi-use terminal
 1-834-813-11



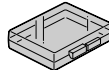
Rechargeable battery pack
(NP-BD1)
 ▲ A-1336-393-A (J)
 ▲ A-1336-394-A (US, CND)
 ▲ A-1336-395-A (EXCEPT CND, US, J)



Instruction Manual
 3-219-483-01 (JAPANESE) (J)
 3-219-483-11 (ENGLISH) (CND, AEP, UK, AUS, E, HK, JE)
 3-219-483-21 (FRENCH, ITALIAN) (CND, AEP)
 3-219-483-31 (SPANISH, PORTUGUESE) (AEP, E, AR, JE)
 3-219-483-41 (GERMAN, DUTCH) (AEP)
 3-219-483-51 (TRADITIONAL CHINESE,
SIMPLIFIED CHINESE) (E, HK, JE)
 3-219-483-61 (RUSSIAN, UKRAINIAN) (AEP)
 3-219-483-71 (ARABIC, PERSIAN) (E)
 3-219-483-81 (KOREAN) (KR, JE)
 3-219-483-91 (POLISH, CZECH) (AEP)
 3-219-484-11 (HUNGARIAN, SLOVAK) (AEP)
 3-219-484-21 (SWEDISH, FINNISH) (AEP)
 3-219-484-31 (NORWEGIAN, DANISH) (AEP)
 3-219-484-41 (THAI, MALAY) (E)
 3-219-484-51 (TURKISH, GREEK) (AEP)
 3-219-484-61 (ENGLISH, SPANISH) (US)
 3-219-484-72 (SIMPLIFIED CHINESE) (CH)



Battery charger
(BC-CSD)
 ▲ 1-480-352-11 (J)
 ▲ 1-480-352-21 (US, CND)
 ▲ 1-480-352-31
(EXCEPT CND, US, J)



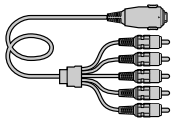
Battery case
(Note 1)



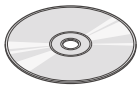
Paint pen
 2-888-952-01 (Black) (BLACK Model)
 2-888-952-11 (Gray)
(SILVER/WHITE/PINK Models)



Wrist strap
 2-050-981-01 (Gray)
(SILVER/WHITE/PINK Models)
 2-050-981-11 (Black) (BLACK Model)



HD Output Adaptor Cable
(DSC-T75 only)
 1-833-859-21



CD-ROM (Cyber-shot application software /
"Cyber-shot Handbook" / "Cyber-shot Step-up
Guide")
 3-219-478-01 (EXCEPT J)
 3-271-036-01 (J)



Cyber-shot Handbook (PDF)

The CD-ROM supplied contains all of language version of
the Instruction Manual in pdf (Cyber-shot Handbook.pdf) for printing.

- The printed matter is not supplied. If required,
please order it with the part number below.

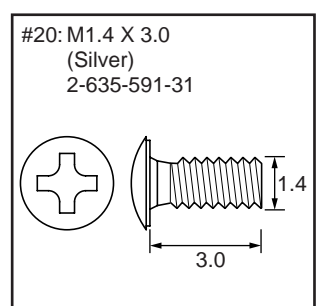
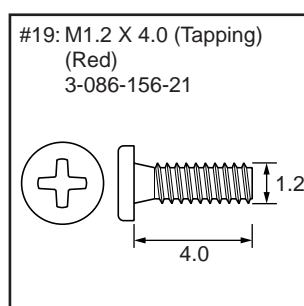
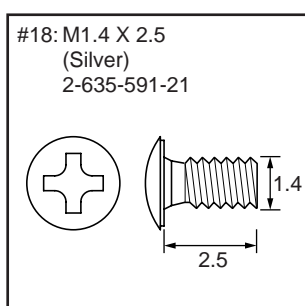
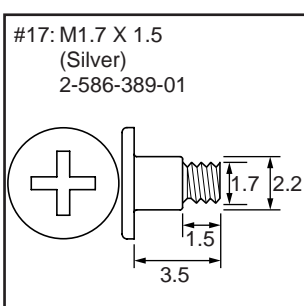
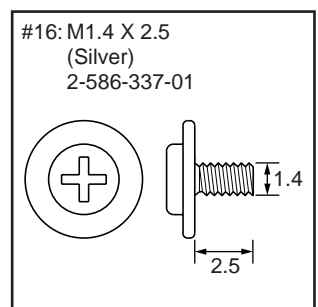
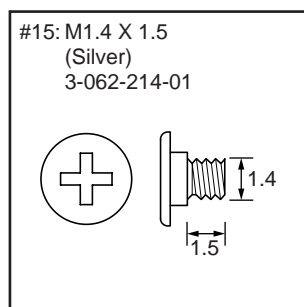
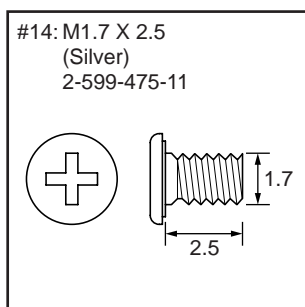
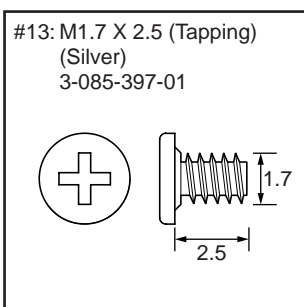
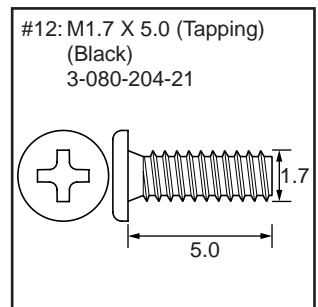
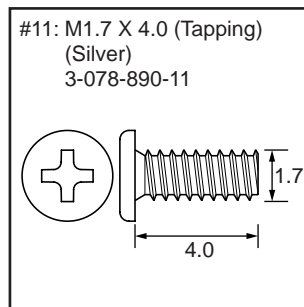
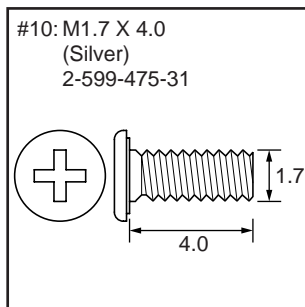
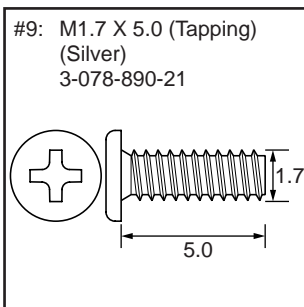
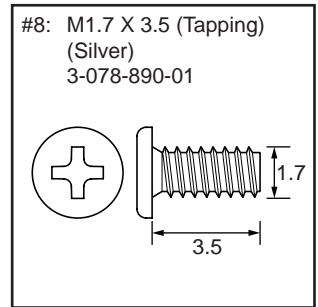
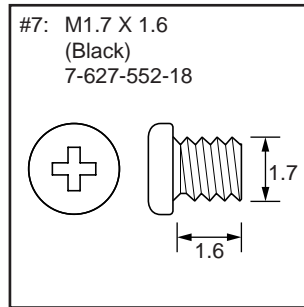
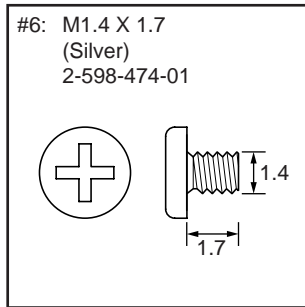
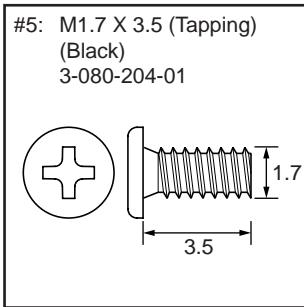
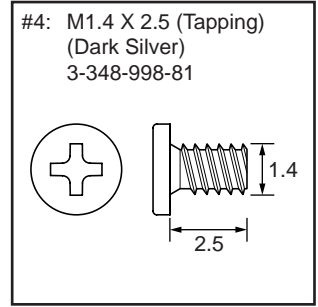
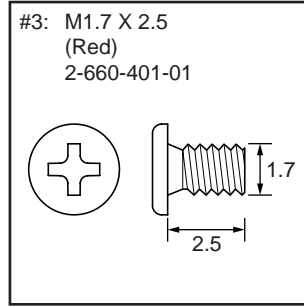
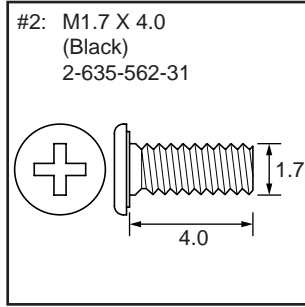
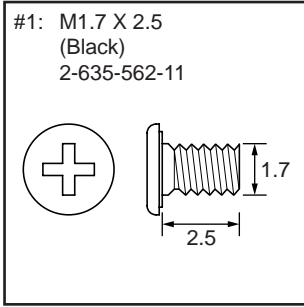
- (Only for destination Japanese model)

日本国内については日本語のみが印刷での部品供給可能です。

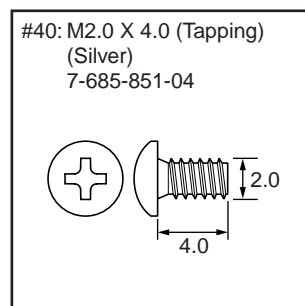
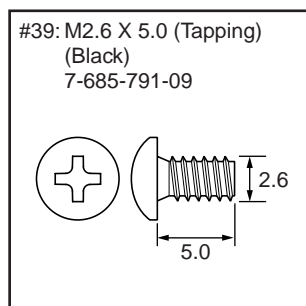
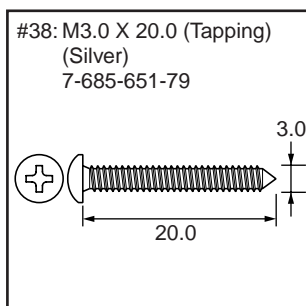
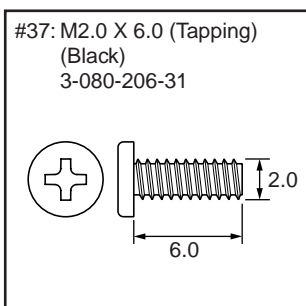
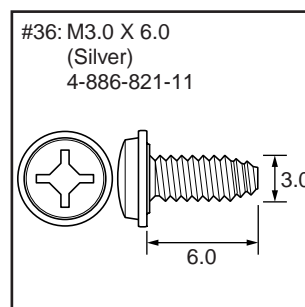
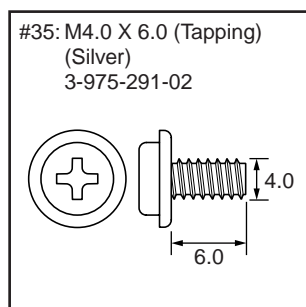
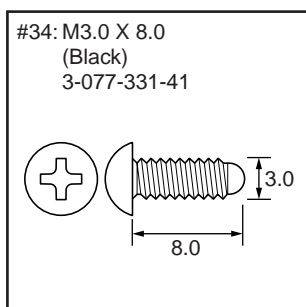
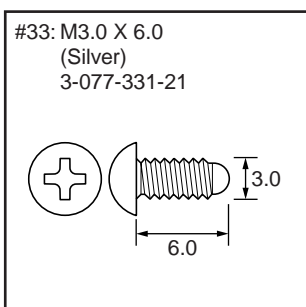
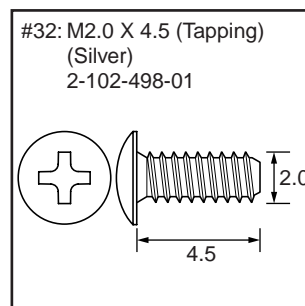
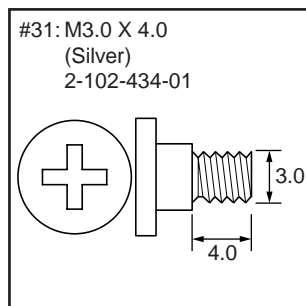
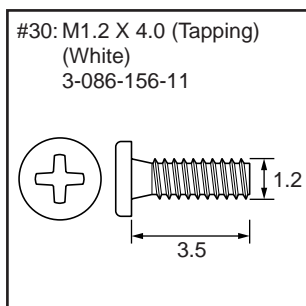
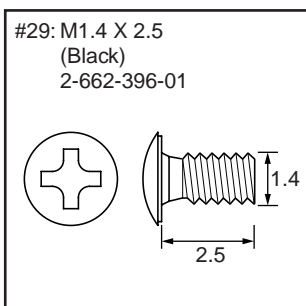
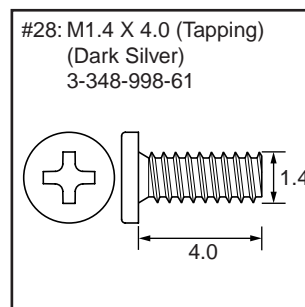
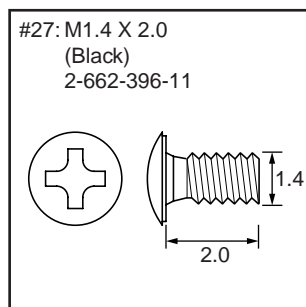
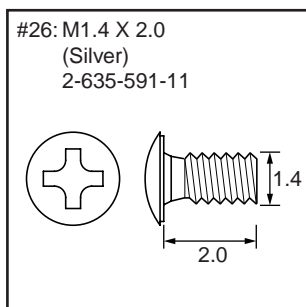
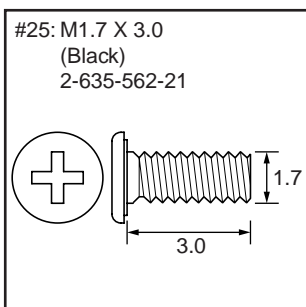
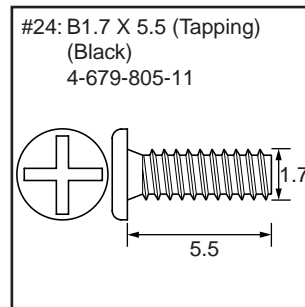
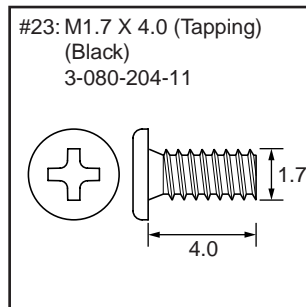
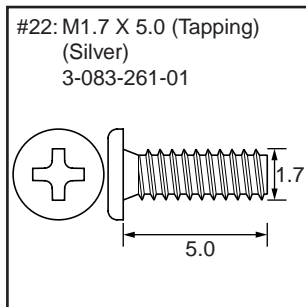
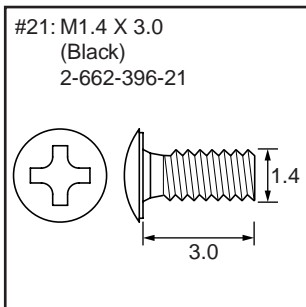
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3-219-480-81 (TRADITIONAL CHINESE)	3-219-482-41 (THAI)
3-219-480-91 (SIMPLIFIED CHINESE)	3-219-482-51 (MALAY)
3-219-481-11 (RUSSIAN)	3-219-482-61 (TURKISH)
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• Refer to the page 5-1 for mark ▲.

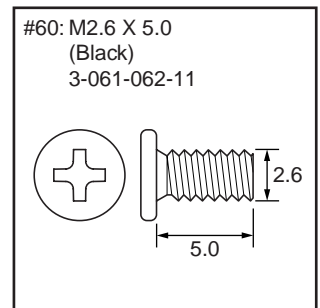
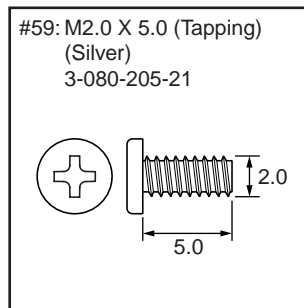
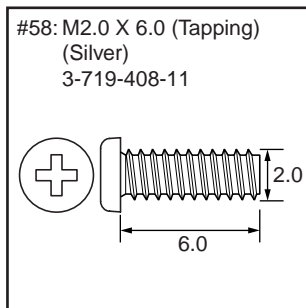
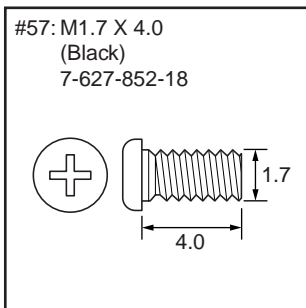
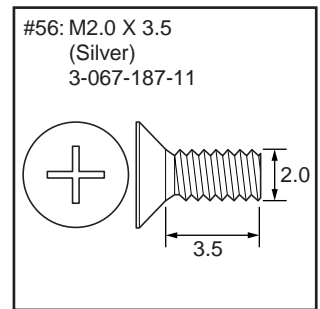
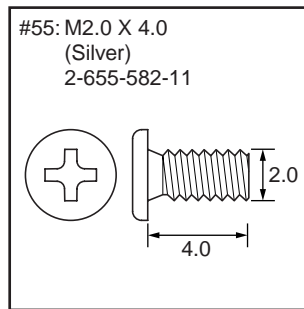
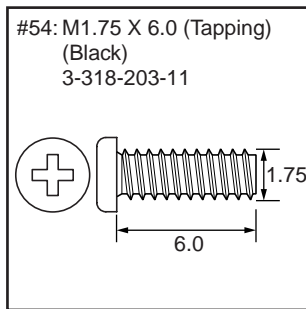
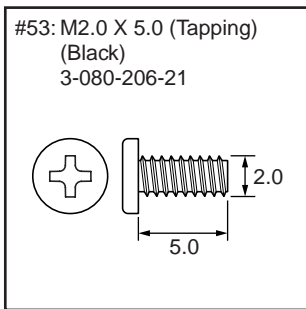
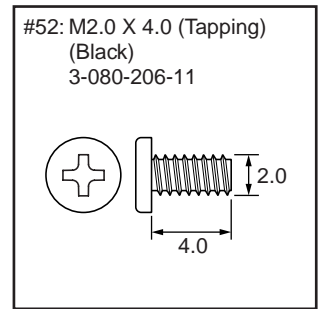
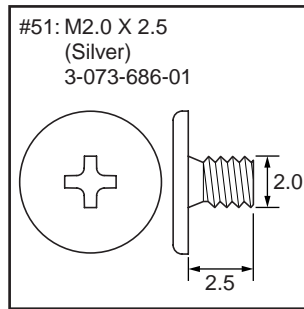
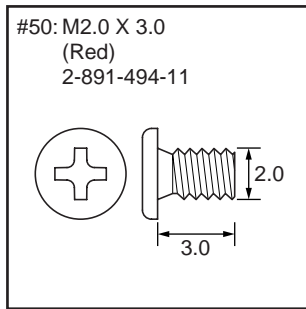
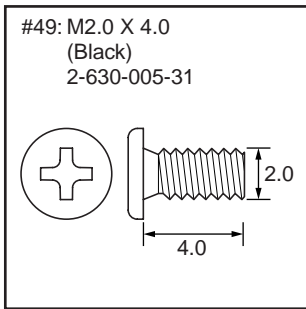
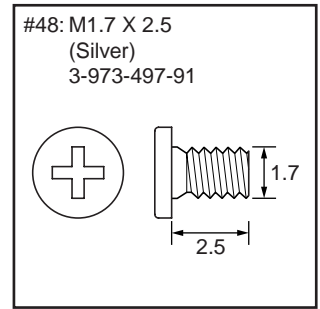
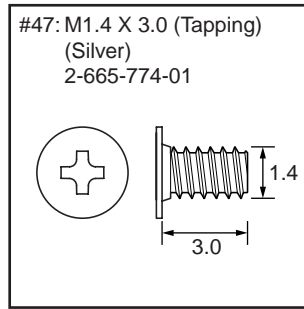
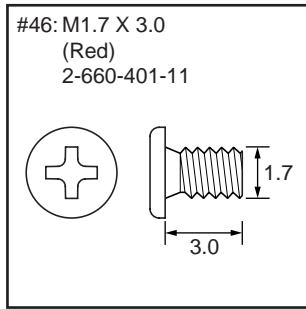
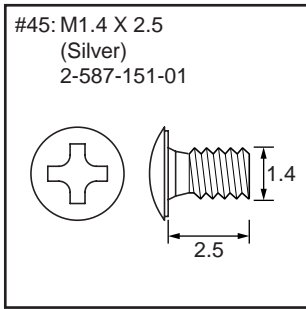
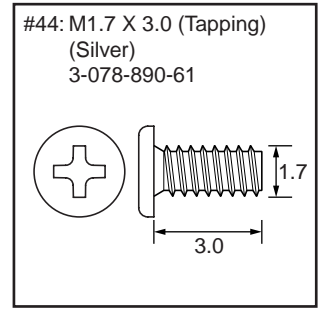
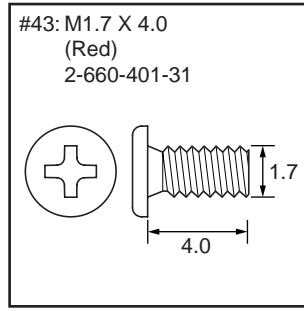
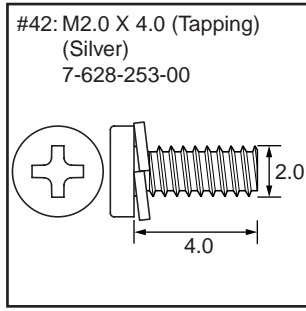
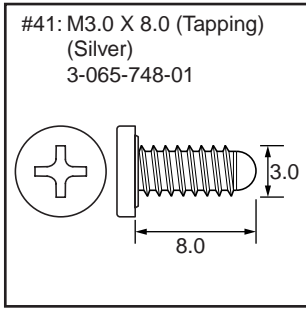
HARDWARE LIST (1/5)



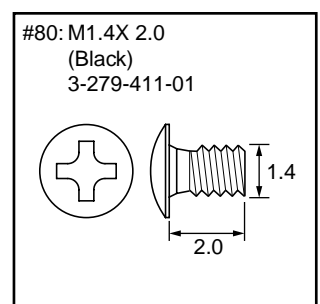
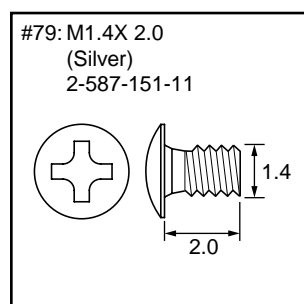
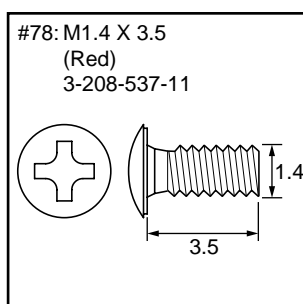
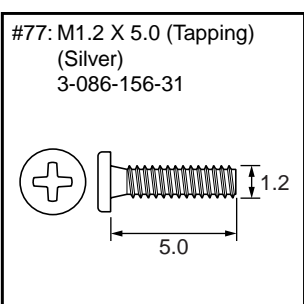
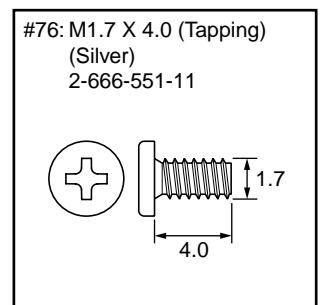
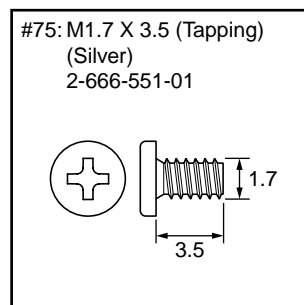
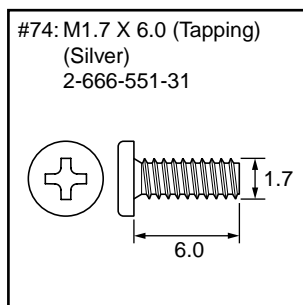
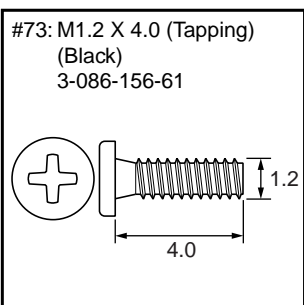
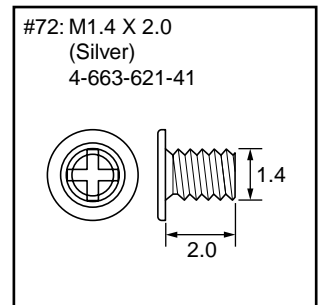
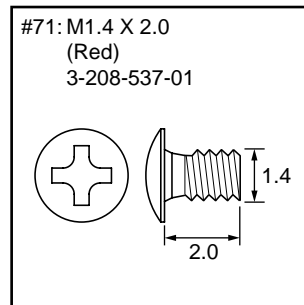
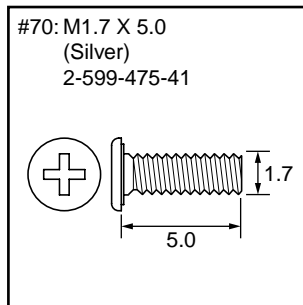
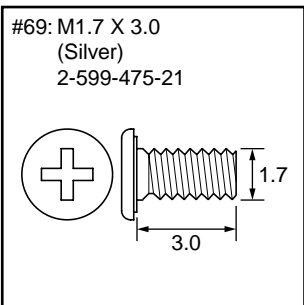
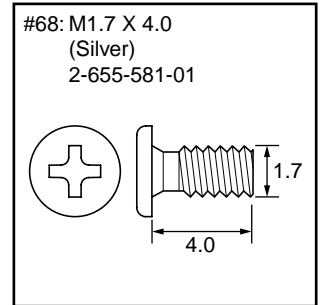
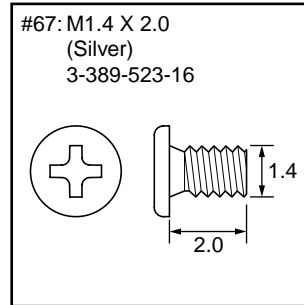
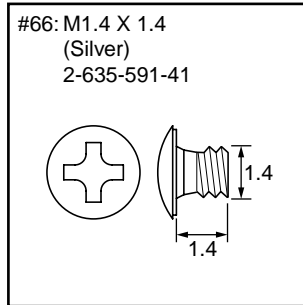
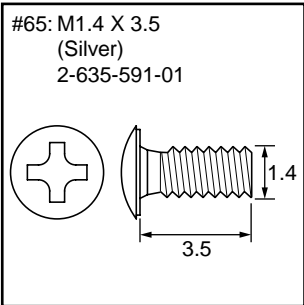
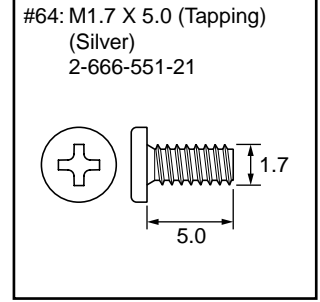
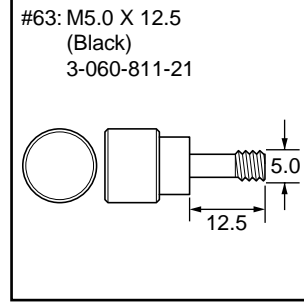
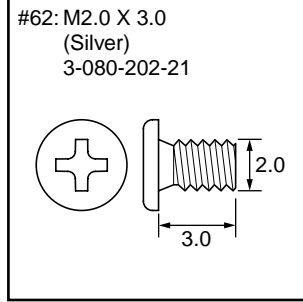
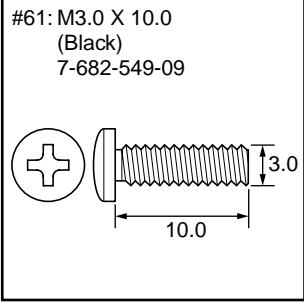
HARDWARE LIST (2/5)



HARDWARE LIST (3/5)

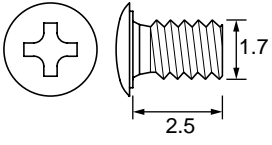


HARDWARE LIST (4/5)

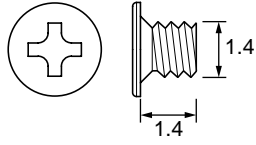


HARDWARE LIST (5/5)

#81: M1.7 X 2.5
(Silver)
2-515-756-01



#82: M1.4 X 1.4
(Silver)
3-272-251-01



Revision History

Ver.	Date	History	Contents	S.M. Rev. issued
1.0	2007.08	Official Release	—	—